

# **PCA9620**

# Universal LCD driver for low multiplex rates

Rev. 1 — 9 December 2010

**Product data sheet** 

# 1. General description

The PCA9620 is a peripheral device which interfaces to almost any Liquid Crystal Display (LCD)<sup>1</sup> with low multiplex rates. It generates the drive signals for any static or multiplexed LCD containing up to eight backplanes, 60 segments, and up to 480 elements. The PCA9620 is compatible with most microprocessors or microcontrollers and communicates via a two-line bidirectional I<sup>2</sup>C-bus. Communication overheads are minimized using a display RAM with auto-incremented addressing and display memory switching. The PCA9620 features an internal charge pump with internal capacitors for on-chip generation of the LCD driving voltages.

AEC Q100 grade 2 compliant for automotive applications.

## 2. Features and benefits

- Low power consumption
- Extended operating temperature range from –40 °C to +105 °C
- 60 segments and 8 backplanes allowing to drive:
  - up to 60 7-segment alphanumeric characters
  - up to 30 14-segment alphanumeric characters
  - ◆ any graphics of up to 480 elements
- 480 bit RAM for display data storage
- Selectable backplane drive configuration: static, 2, 4, 6, or 8 backplane multiplexing
- Programmable internal charge pump for on-chip LCD voltage generation up to  $3 \times V_{DD2}$
- 400 kHz I<sup>2</sup>C-bus interface
- Selectable linear temperature compensation of V<sub>LCD</sub>
- Selectable display bias configuration
- Wide range for digital and analog power supply: from 2.5 V to 5.5 V
- Wide LCD supply range: from 2.5 V for low threshold LCDs and up to 9.0 V for high threshold (automobile) twisted nematic LCDs
- Display memory bank switching in static, duplex, and quadruplex drive modes
- Programmable frame frequency in steps of 10 Hz in the range of 60 Hz to 300 Hz; factory calibrated with a tolerance of ±15 % covering the whole temperature and voltage range
- Selectable inversion scheme for LCD driving waveforms: frame or line inversion
- Integrated temperature sensor with temperature readout
- On chip calibration of internal oscillator frequency and V<sub>I CD</sub>

<sup>1.</sup> The definition of the abbreviations and acronyms used in this data sheet can be found in Section 15 on page 65.



# Universal LCD driver for low multiplex rates

# 3. Ordering information

Table 1. Ordering information

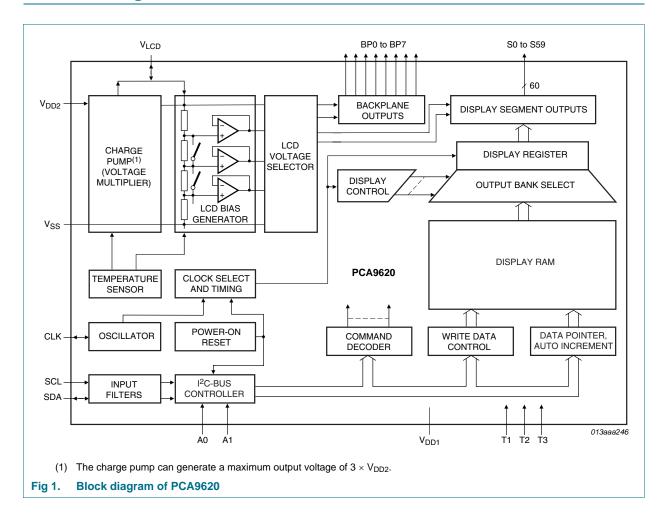
Type number	Package				
	Name	Description	Version		
PCA9620H	LQFP80	plastic low profile quad flat package; 80 leads; body 12 × 12 × 1.4 mm	SOT315-1		

# 4. Marking

Table 2. Marking codes

Type number	Marking code
PCA9620H	PCA9620H/Q900

# 5. Block diagram



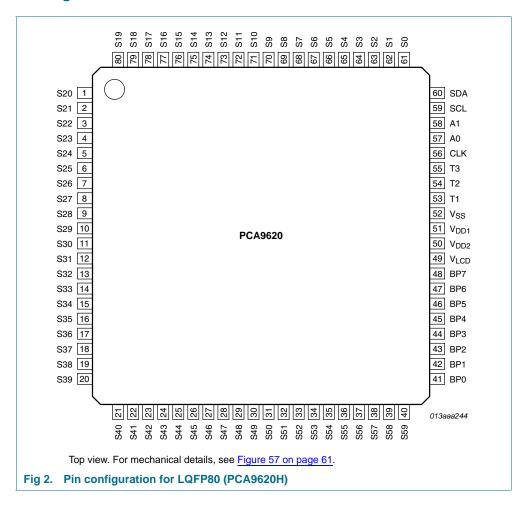
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## Universal LCD driver for low multiplex rates

# 6. Pinning information

# 6.1 Pinning



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# 6.2 Pin description

Table 3. Pin description

Symbol	Pin	Туре	Description
S0 to S59	61 to 80 and 1 to 40	output	LCD segment
BP0 to BP7	41 to 48	output	LCD backplane
V <sub>LCD</sub>	49	supply/output[1]	LCD supply voltage
$V_{DD2}$	50	supply	supply voltage 2 (charge pump)
$V_{DD1}$	51	supply	supply voltage 1 (analog and digital)
V <sub>SS</sub>	52	supply	ground supply voltage
T1 to T3	53 to 55	input	test pins; must be tied to $V_{\mbox{\footnotesize SS}}$ in applications
CLK	56	input/output	internal oscillator output, external oscillator input
A0, A1	57, 58	input	I <sup>2</sup> C-bus slave address selection bit
SCL	59	input	I <sup>2</sup> C-bus serial clock
SDA	60	input/output	I <sup>2</sup> C-bus serial data

<sup>[1]</sup> When the internal  $V_{LCD}$  generation is used, this pin drives the  $V_{LCD}$  voltage. In this case pin  $V_{LCD}$  is an output. When the external supply is requested then pin  $V_{LCD}$  is an input and  $V_{LCD}$  can be supplied to it. In this case the internal charge pump must be disabled (see <u>Table 8 on page 7</u>).

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# 7. Functional description

The PCA9620 is a versatile peripheral device designed to interface any microprocessor or microcontroller to a wide variety of LCDs. It can directly drive any static or multiplexed LCD containing up to 480 elements.

## 7.1 Commands of PCA9620

The PCA9620 is controlled by 22 commands, which are defined in <u>Table 4</u>. Any other combinations of operation code bits that are not mentioned in this document may lead to undesired operation modes of PCA9620.

Table 4. Commands of PCA9620

Command name Bits						Reference			
	7	6	5	4	3	2	1	0	
initialize	0	0	1	1	1	0	1	0	Section 7.1.1
OTP-refresh	1	1	0	1	0	0	0	0	Section 7.1.2
oscillator-ctrl	1	1	0	0	1	1	COE	osc	Section 7.1.3
charge-pump-ctrl	1	1	0	0	0	0	CPE	CPC	Section 7.1.4
temp-msr-ctrl	1	1	0	0	1	0	TCE	TME	Section 7.1.5
temp-comp-SLA	0	0	0	1	1	SLA[2:	:0]		Table 29
temp-comp-SLB	0	0	1	0	0	SLB[2:	:0]		
temp-comp-SLC	0	0	1	0	1	SLC[2	:0]		
temp-comp-SLD	0	0	1	1	0	SLD[2:0]			
set-VPR-MSB	0	1	0	0	VPR[7	':4]			Section 7.1.6
set-VPR-LSB	0	1	0	1	VPR[3	3:0]			
display-enable	0	0	1	1	1	0	0	Е	Section 7.1.7
set-MUX-mode	0	0	0	0	0	M[2:0]			Section 7.1.8
set-bias-mode	1	1	0	0	0	1	B[1:0]		Section 7.1.9
load-data-pointer	1	0	P[5:0]						Section 7.1.10
frame-frequency	0	1	1	F[4:0]					Section 7.1.11
input-bank-select	0	0	0	0	1	IB[2:0]			Section 7.1.12.1
output-bank-select	0	0	0	1	0	OB[2:0	)]		
write-RAM-data	B[7:0]	B[7:0]					Section 7.1.13		
temp-read	TD[7:0	TD[7:0]					Section 7.1.14,		
	<u>Section 7.4.7</u>								
invmode_CPF_ctrl	1	1	0	1	0	1	LF	CPF	<u>Section 7.1.15</u>
temp-filter	1	1	0	1	0	0	1	TFE	Section 7.1.16

#### 7.1.1 Command: initialize

This command generates a chip wide reset which resets all command values to their default values (see <u>Table 25 on page 15</u>). It must be sent to the PCA9620 after power-on. After this command is sent, it is possible to send additional commands without the need to re-initialize the interface. Reset takes 100 ns to complete.

For further information see Section 7.3 on page 14.

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Table 5. Initialize - initialize command bit description

Bit	Symbol	Value	Description
7 to 0	-	00111010	fixed value

#### 7.1.2 Command: OTP-refresh

During production and testing of the device, each IC is calibrated in order to achieve the specified accuracy of  $V_{LCD}$ , the frame frequency, and the temperature measurement. This calibration is performed on EPROM cells called One Time Programmable (OTP) cells. These cells are being read by the device at power-on, after a reset, and every time when the initialize command or the OTP-refresh command is sent. This command will take approximately 10 ms to finish.

Table 6. OTP-refresh - OTP-refresh command bit description

Bit	Symbol	Value	Description
7 to 0	-	11010000	fixed value

#### 7.1.3 Command: oscillator-ctrl

The oscillator-ctrl command switches between internal and external oscillator and enables or disables pin CLK.

Table 7. Oscillator-ctrl - oscillator control command bit description For further information, see Section 7.5 on page 38.

Bit	Symbol	Value	Description
7 to 2	-	110011	fixed value
1	COE		control pin CLK
		0[1]	clock signal not available on pin CLK; pin CLK is in 3-state and may be left floating
		1	clock signal available on pin CLK
0	OSC		oscillator source
		0[1]	internal oscillator running
		1	external oscillator used; pin CLK becomes an input

<sup>[1]</sup> Default value.

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# 7.1.4 Command: charge-pump-ctrl

The charge-pump-ctrl command enables or disables the internal  $V_{LCD}$  generation and controls the charge pump voltage multiplier setting.

Table 8. Charge-pump-ctrl - charge pump control command bit description

Bit	Symbol	Value	Description
7 to 2	-	110000	fixed value
1 CPE		charge pump switch	
	0[1]	charge pump disabled; no internal V <sub>LCD</sub> generation; external supply of V <sub>LCD</sub>	
		1	charge pump enabled
0	CPC		charge pump voltage multiplier setting
		0[1]	$V_{LCD} = 2 \times V_{DD2}$
		1	$V_{LCD} = 3 \times V_{DD2}$

<sup>[1]</sup> Default value.

## 7.1.5 Command: temp-msr-ctrl

The temp-msr-ctrl command enables or disables the temperature measurement block and the temperature compensation of  $V_{\text{LCD}}$ .

Table 9. Temp-msr-ctrl - temperature measurement control command bit description For further information, see Section 7.4.8 on page 36.

Bit	Symbol	Value	Description
7 to 2	-	110010	fixed value
1 TCE	TCE		temperature compensation switch
	0	no temperature compensation of $V_{\text{LCD}}$ possible	
		1[1]	temperature compensation of V <sub>LCD</sub> possible
0	TME		temperature measurement switch
		0	temperature measurement disabled;
			no temperature readout possible
		1[1]	temperature measurement enabled;
			temperature readout possible

<sup>[1]</sup> Default value.

## 7.1.6 Command: set-VPR-MSB and set-VPR-LSB

With these two instructions it is possible to set the target  $V_{LCD}$  voltage for the internal charge pump, see Section 7.4.3 on page 31.

Table 10. Set-VPR-MSB - set VPR MSB command bit description

Bit	Symbol	Value	Description
7 to 4	-	0100	fixed value
3 to 0	VPR[7:4]	0000 <sup>[1]</sup> to 1111	the four most significant bits of VPR[7:0]

<sup>[1]</sup> Default value.

C 4 0 6 2 0

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Table 11. Set-VPR-LSB - set VPR LSB command bit description

Bit	Symbol	Value	Description
7 to 4	-	0101	fixed value
3 to 0	VPR[3:0]	0000 <sup>[1]</sup> to 1111	the four least significant bits of VPR[7:0]

<sup>[1]</sup> Default value.

## 7.1.7 Command: display-enable

Table 12. Display-enable - display enable command bit description

Bit	Symbol	Value	Description
7 to 1	-	0011100	fixed value
0	Е	<u>0[1]</u>	display disabled; backplane and segment outputs are internally connected to V <sub>SS</sub>
		1	display enabled

<sup>[1]</sup> Default value.

#### 7.1.8 Command: set-MUX-mode

Table 13. Set-MUX-mode - set multiplex drive mode command bit description

Bit	Symbol	Value	Description
7 to 3	-	00000	fixed value
2 to 0 M[2:0]	M[2:0]	000 <sup>[1]</sup> , 011, 110, 111	1:8 multiplex drive mode: 8 backplanes
		001	static drive mode: 1 backplane
		010	1:2 multiplex drive mode: 2 backplanes
		100	1:4 multiplex drive mode: 4 backplanes
		101	1:6 multiplex drive mode: 6 backplanes

<sup>[1]</sup> Default value.

## 7.1.9 Command: set-bias-mode

Table 14. Set-bias-mode - set bias mode command bit description

Bit	Symbol	Value	Description
7 to 2	-	110001	fixed value
1 to 0	B[1:0]	00[1], 01	1/ <sub>4</sub> bias
		11	$\frac{1}{3}$ bias
		10	$\frac{1}{2}$ bias

<sup>[1]</sup> Default value.

# 7.1.10 Command: load-data-pointer

The load-data-pointer command defines one of the 60 display RAM addresses where the following display data will be sent to. For further information, see <u>Section 7.9.1 on page 41</u>.

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Table 15. Load-data-pointer - load data pointer command bit description

Bit	Symbol	Value	Description
7 to 6	-	10	fixed value
5 to 0	P[5:0]	000000 to 111111	6-bit binary value of 0 to 59

## 7.1.11 Command: frame-frequency

With the frame-frequency command the frame frequency and the output clock frequency can be configured.

Table 16. Frame frequency - frame frequency and output clock frequency command bit description

Bit	Symbol	Value	Description
7 to 5	-	011	fixed value
4 to 0	F[4:0]	see Table 17	nominal frame frequency (Hz)

Table 17. Frame frequency values

F[4:0]	Nominal frame frequency, f <sub>fr</sub> (Hz)[1]	Resultant oscillator frequency, f <sub>osc</sub> (Hz)	Duty cycle (%)[2]
00000	60	2880	20 : 80
00001	70	3360	7 : 93
00010	80	3840	47 : 53
00011	91	4368	40 : 60
00100	100	4800	33 : 67
00101	109	5232	27 : 73
00110	120	5760	20 : 80
00111	129.7	6226	13 : 87
01000	141.2	6778	5 : 95
01001	150	7200	50 : 50
01010	160	7680	47 : 53
01011	171.4	8227	43 : 57
01100	177.8	8534	41 : 59
01101	192	9216	36 : 64
01110[3]	200	9600	33 : 67
01111	208.7	10018	30 : 70
10000	218.2	10474	27 : 73
10001	228.6	10973	23 : 77
10010	240	11520	20 : 80
10011	252.6	12125	16 : 84
10100, 10101	266.7	12802	10 : 90
10110, 10111	282.4	13555	5 : 95
11000 to 11111	300	14400	50 : 50

<sup>[1]</sup> Nominal frame frequency calculated for the default clock frequency of 9600 Hz.

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<sup>[2]</sup> Duty cycle definition: % HIGH-level time : % LOW-level time.

<sup>[3]</sup> Default value.

# 7.1.12 Bank select commands

For multiplex drive modes 1:4, 1:2 and static drive mode, it is possible to write data to one area of the RAM whilst displaying from another. These areas are named as RAM banks. Input and output banks can be set independently from one another with the input-bank-select and the output-bank-select command. For further information see Section 7.9.2 on page 46.

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#### 7.1.12.1 Command: input-bank-select

Table 18. Input-bank-select - input bank select command bit description[1]

Bit	Symbol	Value	Description			
7 to 3	-	00001	fixed value			
2 to 0 IB[2:0]			selects RAM bank to write to			
			static drive mode	1:2 drive mode	1:4 drive mode	
		000[2]	bank 0: RAM-row 0	bank 0: RAM-rows 0	bank 0: RAM-rows 0,	
		001	bank 1: RAM-row 1	and 1	1, 2, and 3	
		010	bank 2: RAM-row 2	bank 2: RAM-rows 2 and 3		
		011	bank 3: RAM-row 3			
		100	bank 4: RAM-row 4	bank 4: RAM-rows 4	bank 4: RAM-rows 4,	
		101	bank 5: RAM-row 5	and 5	5, 6, and 7	
		110	bank 6: RAM-row 6	bank 6: RAM-rows 6		
		111	bank 7: RAM-row 7	and 7		

<sup>[1]</sup> Not applicable for multiplex drive mode 1:6 and 1:8.

## 7.1.12.2 Command: output-bank-select

Table 19. Output-bank-select - output bank select command bit description[1]

Bit	Symbol	Value	Description		
7 to 3	-	00010	fixed value		
2 to 0	OB[2:0]		selects RAM bank to	read from to the LCD	
			static drive mode	1:2 drive mode	1:4 drive mode
		000[2]	bank 0: RAM-row 0	bank 0: RAM-rows 0	bank 0: RAM-rows 0, 1, 2, and 3
		001	bank 1: RAM-row 1	and 1	
		010	bank 2: RAM-row 2	bank 2: RAM-rows 2	
		011	bank 3: RAM-row 3	and 3	
		100	bank 4: RAM-row 4	bank 4: RAM-rows 4	bank 4: RAM-rows 4,
		101	bank 5: RAM-row 5	and 5	5, 6, and 7
		110	bank 6: RAM-row 6	bank 6: RAM-rows 6	
		111	bank 7: RAM-row 7	and 7	

<sup>[1]</sup> Not applicable for multiplex drive mode 1:6 and 1:8.

<sup>[2]</sup> Default value.

<sup>[2]</sup> Default value.

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### 7.1.13 Command: write-RAM-data

The write-RAM-data command writes data byte-wise to the RAM. After Power-On Reset (POR) the RAM content is random and should be brought to a defined status by clearing it (setting it logic 0).

Table 20. Write-RAM-data - write RAM data command bit description[1]

Bit	Symbol	Value	Description
7 to 0	B[7:0]	00000000 to 11111111	writing data byte-wise to RAM

<sup>[1]</sup> For this command bit RS of the control byte has to be set logic 1 (see Table 33 on page 52).

More information about the display RAM can be found in <u>Section 7.9 on page 40</u>.

# 7.1.14 Command: temp-read

The temp-read command allows reading out the temperature values measured by the internal temperature sensor.

Table 21. Temp-read - temperature readout command bit description [1] For further information, see Table 9 on page 7 and Section 7.4.7 on page 35.

Bit	Symbol	Value	Description
7 to 0	TD[7:0]	00000000 to 11111111	readout representing the digital temperature

<sup>[1]</sup> For this command bit R/W of the I<sup>2</sup>C-bus slave address byte has to be set logic 1 (see <u>Table 32 on page 51</u>).

## 7.1.15 Command: invmode\_CPF\_ctrl

The invmode\_CPF\_ctrl command allows changing the drive scheme inversion mode and the charge pump frequency.

The waveforms used to drive LCD displays inherently produce a DC voltage across the display cell. The PCA9620 will compensate for the DC voltage by inverting the waveforms on alternate frames or alternate lines. The choice of compensation method is determined with the LF bit.

Table 22. Invmode\_CPF\_ctrl - inversion mode and charge pump frequency prescaler command bit description

Bit	Symbol	Value	Description
7 to 2	-	110101	fixed value
1	LF		set inversion mode
		0[1]	line inversion mode
		1	frame inversion mode
0	CPF		set charge pump oscillator frequency
		0[1]	f <sub>osc(cp)</sub> ~ 1 MHz
		1	f <sub>osc(cp)</sub> ~ 500 kHz

<sup>[1]</sup> Default value.

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In frame inversion mode the DC value is compensated across two frames and not within one frame. Changing the inversion mode to frame inversion reduces the power consumption, therefore it is useful when power consumption is a key point in the application.

Frame inversion may not be suitable for all applications. The RMS voltage across a segment is better defined, however since the switching frequency is reduced there is possibility for flicker to occur.

The waveforms of <u>Figure 15 on page 23</u> to <u>Figure 21 on page 29</u> are showing line inversion mode. Figure 22 on page 30 shows one example of frame inversion.

### 7.1.16 Command: temp-filter

Table 23. Temp-filter - digital temperature filter command bit description

Bit	Symbol	Value	Description
7 to 1	-	1101001	fixed value
0	0 TFE digital temperature filter sw		digital temperature filter switch
		0[1]	digital temperature filter disabled; the unfiltered digital value of TD[7:0] is immediately available for the readout and V <sub>LCD</sub> compensation, see Section 7.4.7 on page 35
		1	digital temperature filter enabled

<sup>[1]</sup> Default value.

# 7.2 Possible display configurations

The PCA9620 is a versatile peripheral device designed to interface between any microprocessor or microcontroller to a wide variety of LCD segment or dot matrix displays (see <u>Figure 3</u>). It can directly drive any static or multiplexed LCD containing up to eight backplanes and up to 60 segments.

The display configurations possible with the PCA9620 depend on the number of active backplane outputs required; a selection of possible display configurations is given in Table 24.

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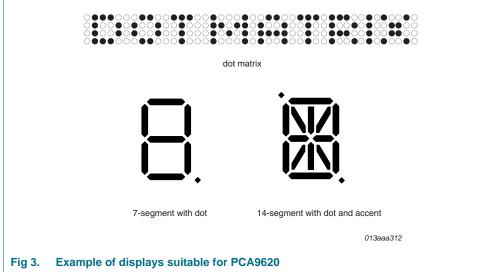
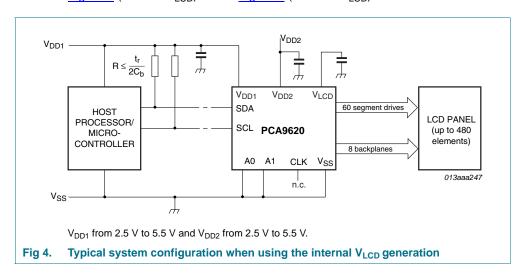


Table 24. Selection of possible display configurations

Number of						
Backplanes	Icons	Digits/Charact	Dot matrix/			
		7-segment	Elements			
8	480	60	30	480 dots (8 × 60)		
6	320	45	22	360 dots (6 × 60)		
4	240	30	15	240 dots (4 × 60)		
2	120	15	7	120 dots (2 × 60)		
1	60	7	3	60 dots (1 × 60)		

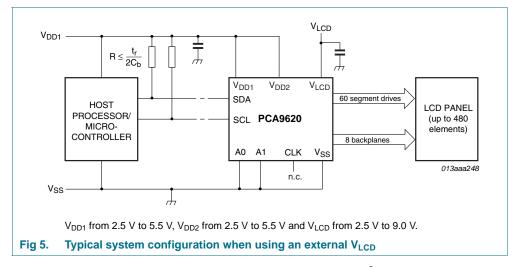
All of the display configurations in <u>Table 24</u> can be implemented in the typical systems shown in <u>Figure 4</u> (internal  $V_{LCD}$ ) and in <u>Figure 5</u> (external  $V_{LCD}$ ).



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The host microprocessor or microcontroller maintains the 2 line  $I^2C$ -bus communication channel with the PCA9620. The appropriate biasing voltages for the multiplexed LCD waveforms are generated internally. The only other connections required to complete the system are the power supplies ( $V_{DD1}$ ,  $V_{DD2}$ ,  $V_{SS}$ ,  $V_{LCD}$ ), the external capacitors, and the LCD panel selected for the application.

The minimum recommended values for external capacitors on  $V_{DD1}$ ,  $V_{DD2}$ , and  $V_{LCD}$  are nominal 100 nF. When using bigger capacitors, especially on the  $V_{LCD}$ , the generated ripple will be consequently smaller, however it will take longer for the internal charge pump to first reach the target  $V_{LCD}$  voltage.

In the case that  $V_{DD1}$  and  $V_{DD2}$  are connected externally, the capacitors on  $V_{DD1}$  and  $V_{DD2}$  can be replaced by a single capacitor with a minimum value of 200 nF.

**Remark:** In the case of insufficient decoupling, ripple of  $V_{DD1}$  and  $V_{DD2}$  will create additional  $V_{LCD}$  ripple. The ripple on  $V_{LCD}$  can be reduced by making the  $V_{SS}$  connection as low-ohmic as possible. Excessive ripple on  $V_{LCD}$  may give rise to flicker on the display.

#### 7.3 Start-up and shut-down

#### 7.3.1 Power-On Reset (POR)

At power-on the PCA9620 resets to starting conditions as follows:

- 1. All backplane outputs are set to V<sub>SS</sub>.
- 2. All segment outputs are set to VSS.
- 3. Selected drive mode is: 1:8 with  $\frac{1}{4}$  bias.
- 4. Input and output bank selectors are reset.
- 5. The I<sup>2</sup>C-bus interface is initialized.
- 6. The data pointer is cleared (set logic 0).
- 7. The Internal oscillator is running; no clock signal is available on pin CLK; pin CLK is in 3-state.
- 8. Temperature measurement is enabled.

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- 9. Temperature filter is disabled.
- 10. The internal V<sub>LCD</sub> voltage generation is disabled. The charge pump is switched off.
- 11. The V<sub>LCD</sub> temperature compensation is enabled.
- 12. The display is disabled.

**Remark:** Do not transfer data on the  $I^2C$ -bus for at least 1 ms after a power-on to allow the reset action to complete.

The first command sent to the device after the power-on event must be the initialize command (see Section 7.1.1 on page 5).

After Power-On Reset (POR) and before enabling the display, the RAM content should be brought to a defined status

- by clearing it (setting it all logic 0) or
- by writing meaningful content (e.g. a graphic)

otherwise unwanted display artifacts may appear on the display.

**Table 25. Reset states**Bits labeled - are undefined at power-on.

Command name	Bits							
	7	6	5	4	3	2	1	0
initialize	0	0	1	1	1	0	1	0
OTP-refresh	1	1	0	1	0	0	0	0
oscillator-ctrl	1	1	0	0	1	1	0	0
charge-pump-ctrl	1	1	0	0	0	0	0	0
temp-msr-ctrl	1	1	0	0	1	0	1	1
temp-comp-SLA	0	0	0	1	1	0	0	0
temp-comp-SLB	0	0	1	0	0	0	0	0
temp-comp-SLC	0	0	1	0	1	0	0	0
temp-comp-SLD	0	0	1	1	0	0	0	0
set-VPR-MSB	0	1	0	0	0	0	0	0
set-VPR-LSB	0	1	0	1	0	0	0	0
display-enable	0	0	1	1	1	0	0	0
set-MUX-mode	0	0	0	0	0	0	0	0
set-bias-mode	1	1	0	0	0	1	0	0
load-data-pointer	1	0	0	0	0	0	0	0
frame-frequency	0	1	1	0	1	1	1	0
input-bank-select	0	0	0	0	1	0	0	0
output-bank-select	0	0	0	1	0	0	0	0
write-RAM-data	-	-	-	-	-	-	-	-
temp-read	0	1	0	0	0	0	0	0
invmode_CPF_ctrl	1	1	0	1	0	1	0	0
temp-filter	1	1	0	1	0	0	1	0

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# 7.3.2 Recommended start-up sequences

This chapter describes how to proceed with the initialization of the chip in different application modes.

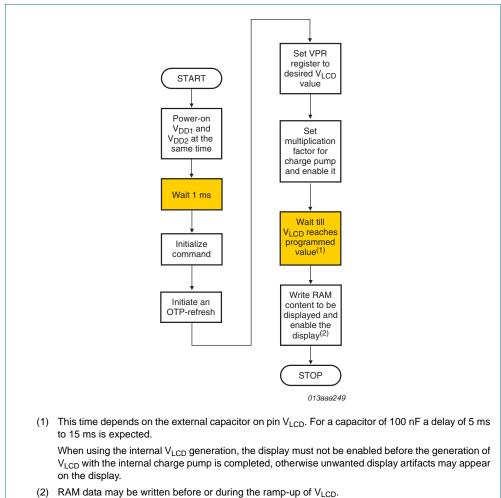


Fig 6. Recommended start-up sequence when using the internal charge pump and the

internal clock signal

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## Universal LCD driver for low multiplex rates

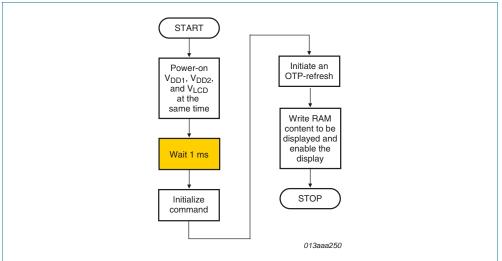
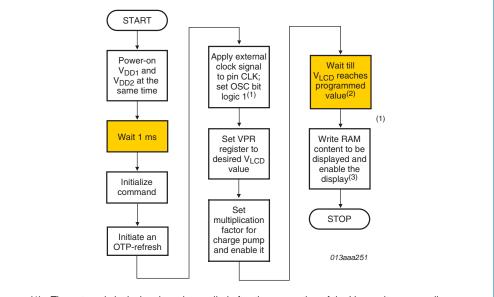


Fig 7. Recommended start-up sequence when using an external supplied V<sub>LCD</sub> and the internal clock signal



- (1) The external clock signal can be applied after the generation of the  $V_{LCD}$  voltage as well.
- (2) This time depends on the external capacitor on pin  $V_{LCD}$ . For a capacitor of 100 nF a delay of 5 ms to 15 ms is expected.
- (3) RAM data may be written before or during the ramp-up of  $V_{LCD}$ .

Fig 8. Recommended start-up sequence when using the internal charge pump and an external clock signal

#### Universal LCD driver for low multiplex rates

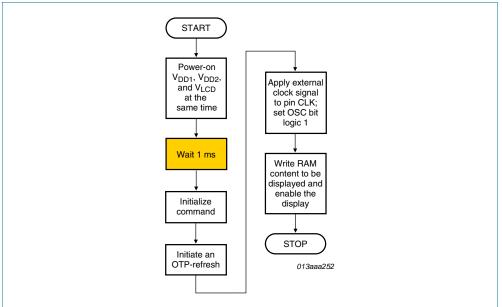


Fig 9. Recommended start-up sequence when using an external supplied  $V_{\text{LCD}}$  and an external clock signal

## 7.3.3 Recommended power-down sequences

With the following sequences the PCA9620 can be set to a state of minimum power consumption, called power-down mode.

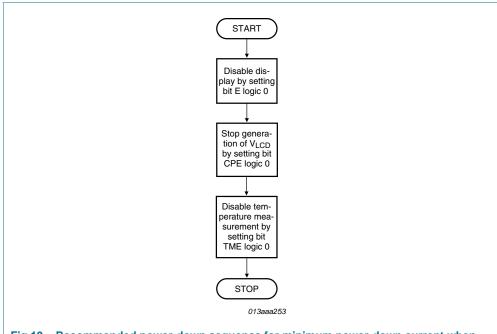


Fig 10. Recommended power-down sequence for minimum power-down current when using the internal charge pump and the internal clock signal

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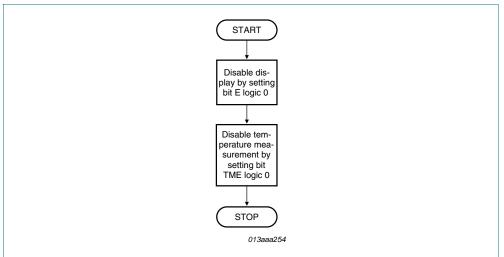


Fig 11. Recommended power-down sequence when using an external supplied  $V_{\text{LCD}}$  and the internal clock signal

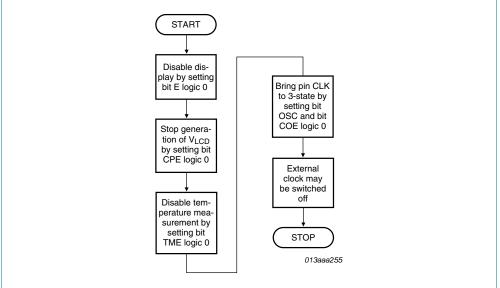
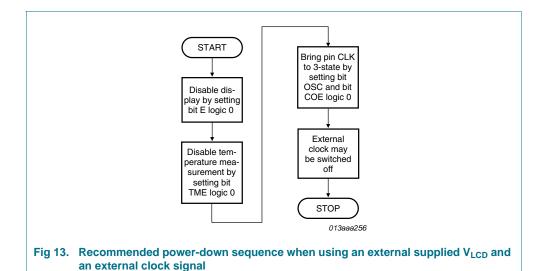


Fig 12. Recommended power-down sequence when using the internal charge pump and an external clock signal

#### Universal LCD driver for low multiplex rates



**Remark:** It is necessary to run the power-down sequence before removing the supplies. Depending on the application, care must be taken that no other signals are present at the chip input or output pins when removing the supplies (please refer to <a href="Section 9 on page 53">Section 9 on page 53</a>). Otherwise this may cause unwanted display artifacts. In case of uncontrolled removal of supply voltages the PCA9620 will not be damaged.

**Remark:** Static voltages across the liquid crystal display can build up when the external LCD supply voltage ( $V_{LCD}$ ) is on while the IC supply voltage ( $V_{DD1}$  or  $V_{DD2}$ ) is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts, external  $V_{LCD}$ ,  $V_{DD1}$ , and  $V_{DD2}$  must be applied or removed together.

**Remark:** A clock signal must always be supplied to the device when the device is active; removing the clock may freeze the LCD in a DC state, which is not suitable for the liquid crystal. It is recommended to first disable the display and afterwards to remove the clock signal.

## 7.4 LCD voltage

# 7.4.1 LCD voltage selector

The LCD voltage selector co-ordinates the multiplexing of the LCD in accordance with the selected LCD drive configuration. The operation of the voltage selector is controlled by the set-bias-mode command (see <u>Table 14 on page 8</u>) and the set-MUX-mode command (see <u>Table 13 on page 8</u>).

Intermediate LCD biasing voltages are obtained from an internal voltage divider. The biasing configurations that apply to the preferred modes of operation, together with the biasing characteristics as functions of  $V_{LCD}$  and the resulting discrimination ratios (D), are given in <u>Table 26</u>.

Discrimination is a term which is defined as the ratio of the on and off RMS voltage across a segment. It can be thought of as a measurement of contrast.

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#### Universal LCD driver for low multiplex rates

Table 26. LCD drive modes: summary	of	characteristics
------------------------------------	----	-----------------

LCD drive Number of:			LCD bias	$V_{off(RMS)}$	$V_{on(RMS)}$	$D = \frac{V_{on(RMS)}}{V} [1]$	V <sub>LCD</sub> [2]	
mode	Backplanes	Levels	configuration	$\overline{V_{LCD}}$	$\overline{V_{LCD}}$	$D = \frac{V_{off(RMS)}}{V_{off(RMS)}}$		
static	1	2	static	0	1	$\infty$	V <sub>on(RMS)</sub>	
1:2 multiplex	2	3	1/2	0.354	0.791	2.236	$2.828 \times V_{off(RMS)}$	
1:2 multiplex	2	4	1/3	0.333	0.745	2.236	$3.0 \times V_{off(RMS)}$	
1:2 multiplex[3]	2	5	1/4	0.395	0.729	1.845	$2.529 \times V_{off(RMS)}$	
1:4 multiplex[3]	4	3	1/2	0.433	0.661	1.527	$2.309 \times V_{off(RMS)}$	
1:4 multiplex	4	4	1/3	0.333	0.577	1.732	$3.0 \times V_{off(RMS)}$	
1:4 multiplex[3]	4	5	1/4	0.331	0.545	1.646	$3.024 \times V_{off(RMS)}$	
1:6 multiplex[3]	6	3	1/2	0.456	0.612	1.341	$2.191 \times V_{off(RMS)}$	
1:6 multiplex	6	4	1/3	0.333	0.509	1.527	$3.0 \times V_{off(RMS)}$	
1:6 multiplex	6	5	1/4	0.306	0.467	1.527	$3.266 \times V_{off(RMS)}$	
1:8 multiplex[3]	8	3	1/2	0.467	0.586	1.254	$2.138 \times V_{off(RMS)}$	
1:8 multiplex[3]	8	4	1/3	0.333	0.471	1.414	$3.0 \times V_{off(RMS)}$	
1:8 multiplex	8	5	1/4	0.293	0.424	1.447	$3.411 \times V_{off(RMS)}$	

<sup>[1]</sup> Determined from Equation 3.

A practical value for  $V_{LCD}$  is determined by equating  $V_{off(RMS)}$  with a defined LCD threshold voltage ( $V_{th}$ ), typically when the LCD exhibits approximately 10 % contrast. In the static drive mode a suitable choice is  $V_{LCD} > 3V_{th}$ .

Bias is calculated by  $\frac{1}{1+a}$ , where the values for a are

a = 1 for  $\frac{1}{2}$  bias

a = 2 for  $\frac{1}{3}$  bias

a = 3 for  $\frac{1}{4}$  bias

The RMS on-state voltage  $(V_{on(RMS)})$  for the LCD is calculated with Equation 1:

$$V_{on(RMS)} = V_{LCD} \sqrt{\frac{a^2 + 2a + n}{n \times (1 + a)^2}}$$
 (1)

where V<sub>LCD</sub> is the resultant voltage at the LCD segment and where the values for n are

n = 1 for static mode

n = 2 for 1:2 multiplex

n = 4 for 1:4 multiplex

n = 6 for 1:6 multiplex

n = 8 for 1:8 multiplex

The RMS off-state voltage (Voff(RMS)) for the LCD is calculated with Equation 2:

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<sup>[2]</sup> Determined from Equation 2.

<sup>[3]</sup> In this examples the discrimination factor and hence the contrast ratios are smaller. The advantage of these LCD drive modes is a power saving from a reduction of the LCD voltage V<sub>LCD</sub>.

## Universal LCD driver for low multiplex rates

$$V_{off(RMS)} = V_{LCD} \sqrt{\frac{a^2 - 2a + n}{n \times (1 + a)^2}}$$
 (2)

Discrimination is the ratio of  $V_{on(RMS)}$  to  $V_{off(RMS)}$  and is determined from Equation 3:

$$\frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{(a+1)^2 + (n-1)}{(a-1)^2 + (n-1)}}$$
(3)

It should be noted that V<sub>LCD</sub> is sometimes referred as the LCD operating voltage.

#### 7.4.1.1 Electro-optical performance

Suitable values for  $V_{on(RMS)}$  and  $V_{off(RMS)}$  are dependant on the LCD liquid used. The RMS voltage, at which a pixel will be switched on or off, determine the transmissibility of the pixel.

For any given liquid, there are two threshold values defined. One point is at 10 % relative transmission (at  $V_{low}$ ) and the other at 90 % relative transmission (at  $V_{high}$ ), see <u>Figure 14</u>. For a good contrast performance, the following rules should be followed:

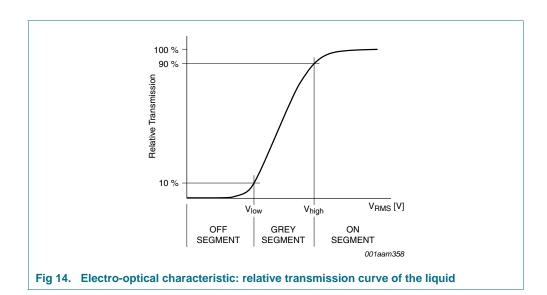
$$V_{on(RMS)} \ge V_{high} \tag{4}$$

$$V_{off(RMS)} \le V_{low} \tag{5}$$

 $V_{on(RMS)}$  and  $V_{off(RMS)}$  are properties of the display driver and are affected by the selection of a, n (see Equation 1 to Equation 3) and the  $V_{LCD}$  voltage.

 $V_{\text{low}}$  and  $V_{\text{high}}$  are properties of the LCD liquid and can be provided by the module manufacturer.

It is important to match the module properties to those of the driver in order to achieve optimum performance.



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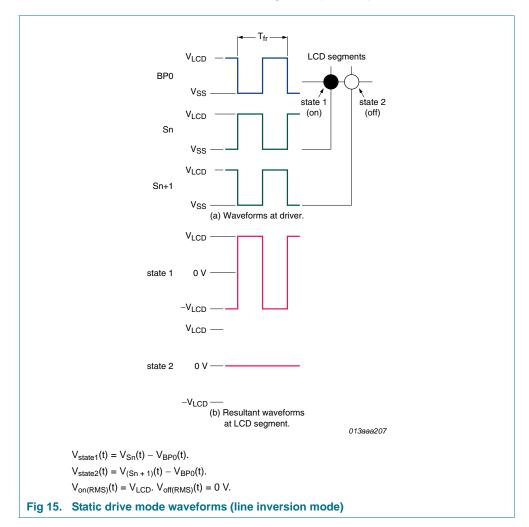
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## Universal LCD driver for low multiplex rates

## 7.4.2 LCD drive mode waveforms

#### 7.4.2.1 Static drive mode

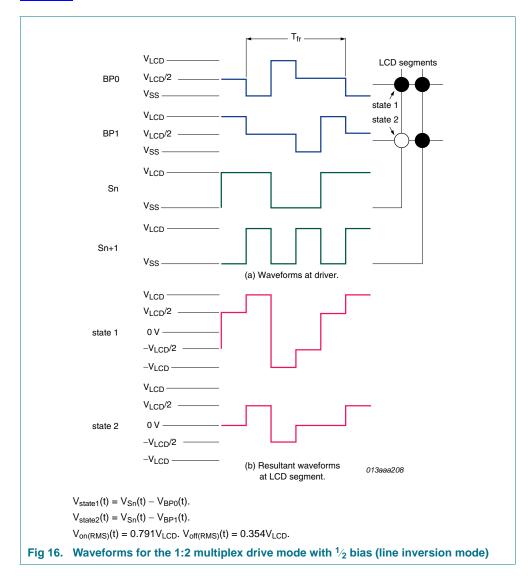
The static LCD drive mode is used when a single backplane is provided in the LCD.



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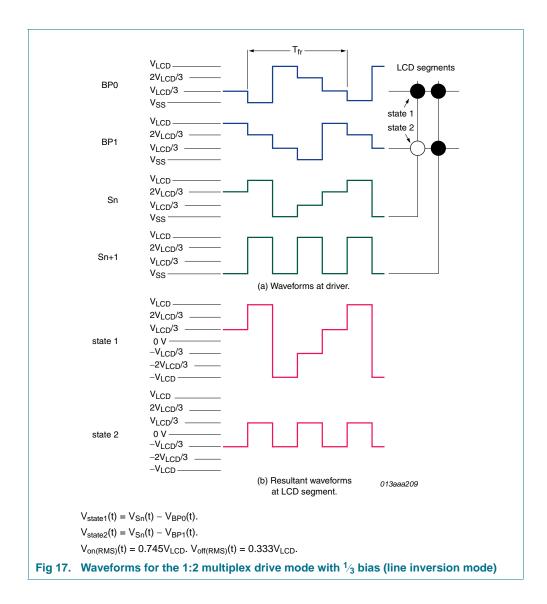
# 7.4.2.2 1:2 Multiplex drive mode

When two backplanes are provided in the LCD, the 1:2 multiplex mode applies. The PCA9620 allows the use of  $\frac{1}{2}$  bias or  $\frac{1}{3}$  bias in this mode as shown in Figure 16 and Figure 17.



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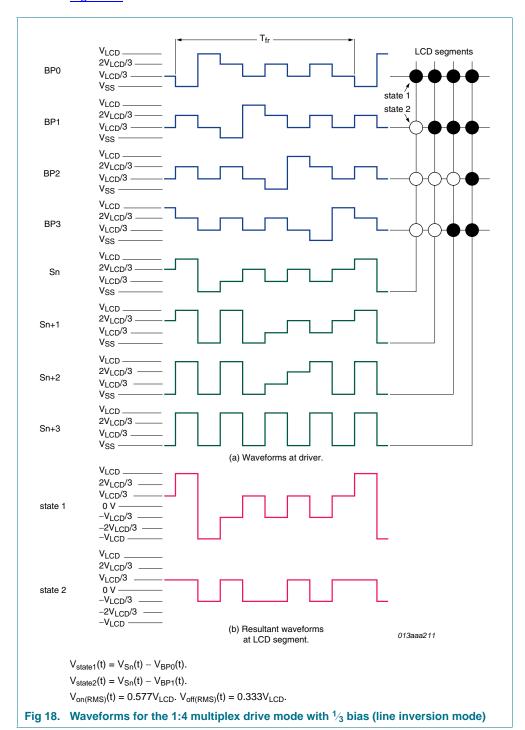
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# 7.4.2.3 1:4 Multiplex drive mode

When four backplanes are provided in the LCD, the 1:4 multiplex drive mode applies, as shown in Figure 18.

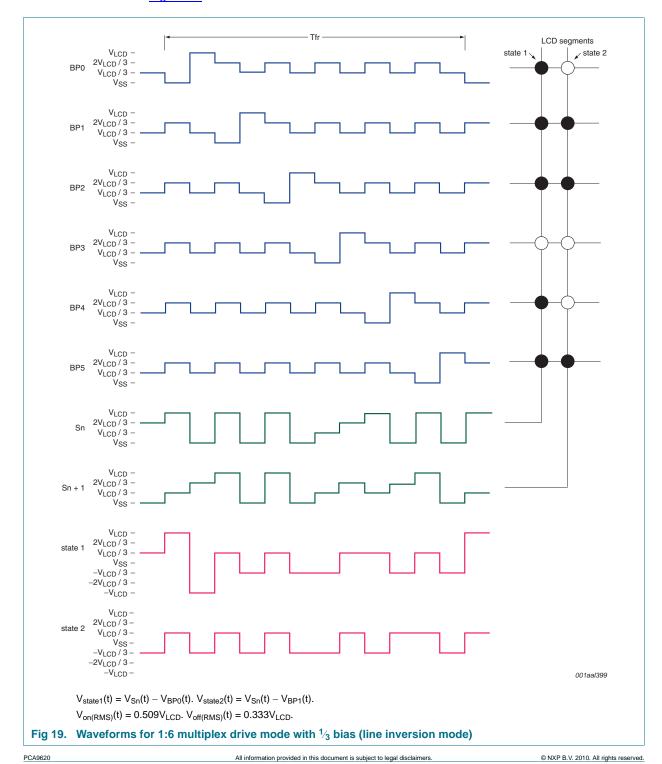


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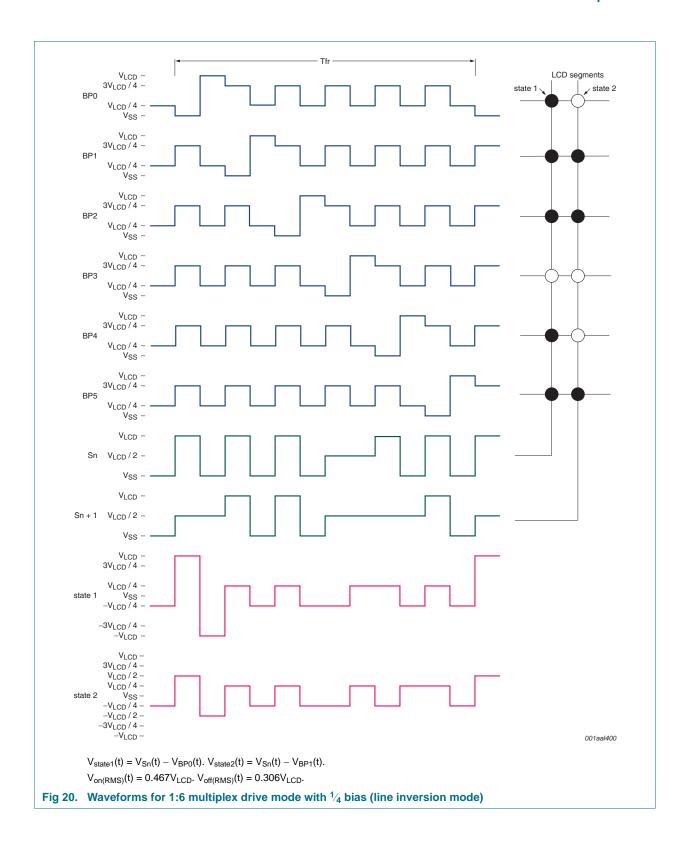
## 7.4.2.4 1:6 Multiplex drive mode

When six backplanes are provided in the LCD, the 1:6 multiplex drive mode applies. The PCA9620 allows the use of  $\frac{1}{3}$  bias or  $\frac{1}{4}$  bias in this mode as shown in Figure 19 and Figure 20.



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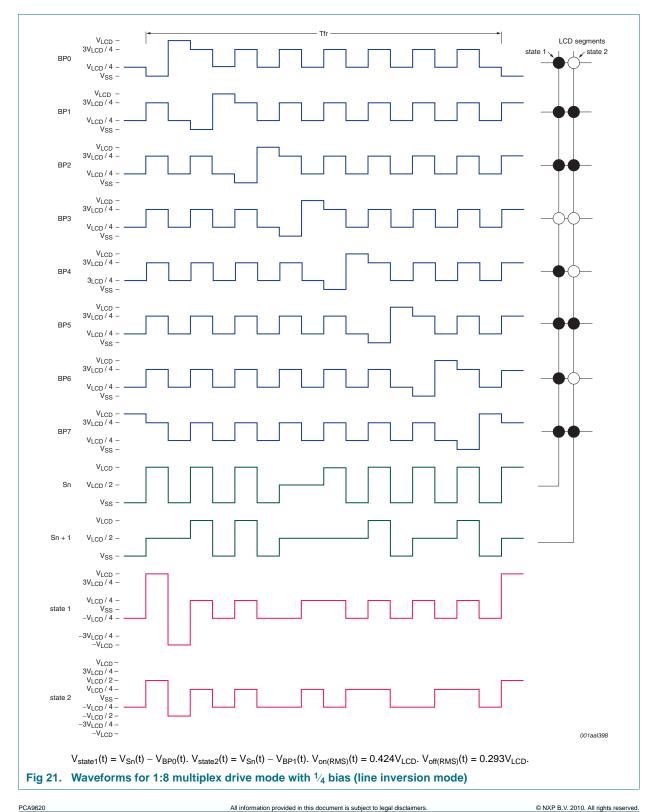
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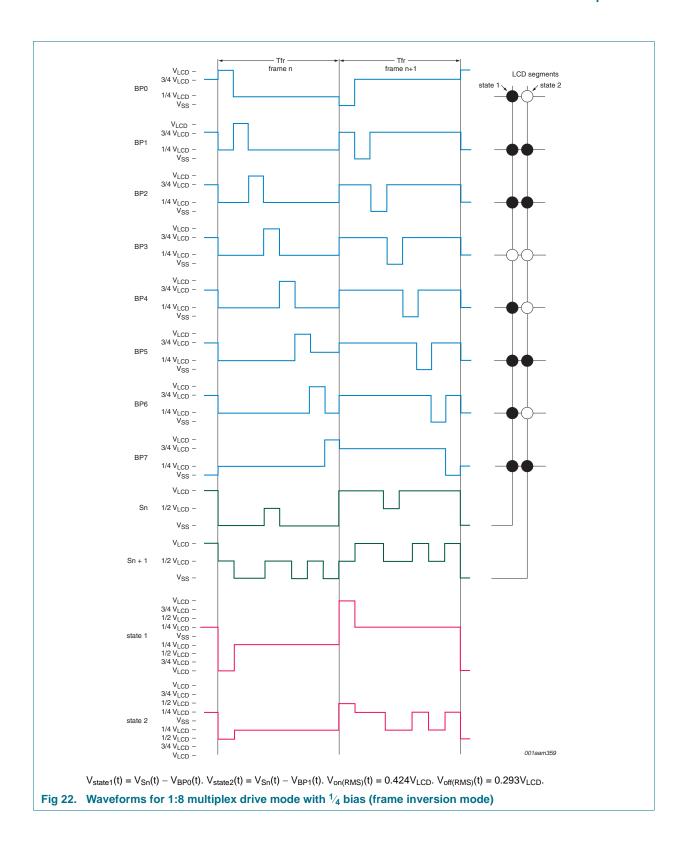
7.4.2.5 1:8 Multiplex drive mode



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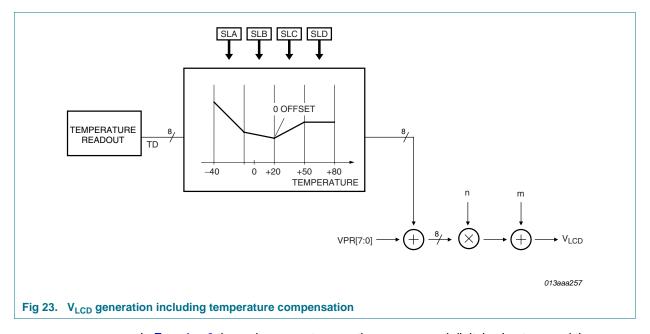
When eight backplanes are provided in the LCD, the 1:8 multiplex drive mode applies, as shown in Figure 21 and Figure 22.

# 7.4.3 V<sub>LCD</sub> generation

 $V_{LCD}$  can be generated and controlled on the chip by using software commands. When the internal charge pump is used, the programmed  $V_{LCD}$  is available on pin  $V_{LCD}$ . The charge pump generates a  $V_{LCD}$  of up to  $3 \times V_{DD2}$ .

The charge pump can be enabled or disabled with the CPE bit (see <u>Table 8 on page 7</u>). With bit CPC the charge pump multiplier setting can be configured.

The final value of  $V_{LCD}$  is a combination of the programmed VPR[7:0] value and the output of the temperature compensation block, VT[7:0]. The system is shown in Figure 23.



In <u>Equation 6</u> the main parameters are the programmed digital value term and the compensated temperature term.

$$V_{LCD} = [VPR[7:0] + VT[7:0]] \times n + m$$
(6)

- 1. VPR[7:0] is the binary value of the programmed voltage.
- 2. VT[7:0] is the binary value of the temperature compensated voltage. Its value comes from the temperature compensation block and is a two's complement which has the value 0h at 20  $^{\circ}$ C.
- 3. m and n are fixed values (see Table 27).

Table 27. Parameters of V<sub>LCD</sub> generation

Symbol	Value	Unit
m	3	V
n	0.03	V

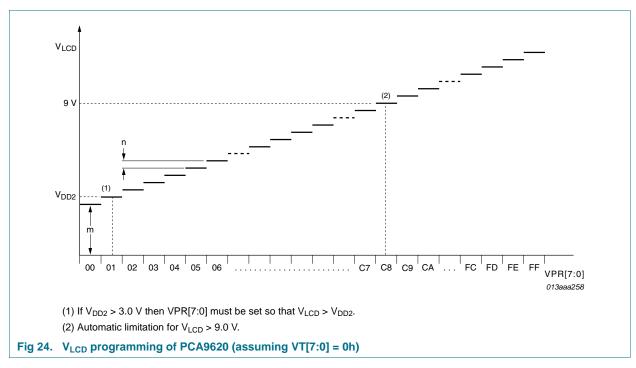
Figure 24 shows how V<sub>LCD</sub> changes with the programmed value of VPR[7:0].

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It has to be taken into account that the charge pump has to be configured (via bit CPC) properly to obtain the desired voltage range. For example, if  $V_{DD2} = 3.0 \text{ V}$  and CPC is set to  $2 \times V_{DD2}$  (logic 0) then the maximum theoretical value that the charge pump can reach is  $V_{LCD} = 6.0 \text{ V}$ . But in reality, lower values will be reached due to internal resistances, see Section 7.4.5. So, if the requested value for  $V_{LCD} = 7.0 \text{ V}$  then the charge pump has to be configured with CPC set to  $3 \times V_{DD2}$  (logic 1).



Programmable range of VPR[7:0] is from 0h to FFh. This would allow to achieve  $V_{LCD} > 9.0 \text{ V}$ , but the PCA9620 has a built-in automatic limitation of  $V_{LCD}$  at 9.0 V.

In case that  $V_{DD2}$  is higher than 3.0 V, then it is important that VPR[7:0] is set to a value such that the resultant  $V_{LCD}$  (including the temperature correction of VT[7:0]) is higher than  $V_{DD2}$ .

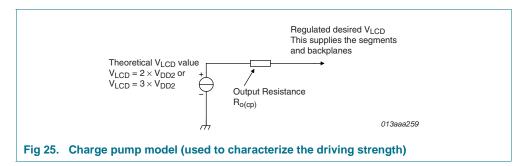
## 7.4.4 External V<sub>LCD</sub> supply

 $V_{LCD}$  can be directly supplied to the  $V_{LCD}$  pin. In this case the internal charge pump must not be enabled otherwise a high current may occur on pin  $V_{DD2}$  and pin  $V_{LCD}$ . When  $V_{LCD}$  is supplied externally, no internal temperature compensation occurs on this voltage even if bit TCE is set logic 1 (see Section 7.4.8 on page 36). The  $V_{LCD}$  voltage which is supplied externally will be available at the segments and backplanes of the device through the chosen bias system. Also programming the VPR[7:0] bit field has no effect on the  $V_{LCD}$  which is externally supplied.

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## 7.4.5 Charge pump driving capability

Figure 25 illustrates the main factor determining how much current the charge pump can deliver.



The output resistance of the charge pump is specified in <u>Table 35 on page 55</u>. With these values it can be calculated how much current the charge pump can drive under certain conditions.

Example: Assuming the user would like to have the normal operation point at 25 °C with  $V_{LCD} = 7.0 \text{ V}$  and  $V_{DD2} = 5.0 \text{ V}$  and the charge pump is set to  $2 \times V_{DD2}$ . Then the theoretical value of  $V_{LCD}$  is 10.0 V and the desired one is 7.0 V. The difference between the theoretical maximum value and desired one is 3.0 V. The charge pump resistance is nominally 0.85 k $\Omega$ . Equation 7 shows the possible current that the charge pump could deliver:

$$I_{load} = \Delta V_{LCD} / R_{o(cp)} \tag{7}$$

For this example we get:  $I_{load} = 3.0 \text{ V}/0.85 \text{ k}\Omega = 3.5 \text{ mA}$ 

In cases where no extreme driving capability is needed, a command is available for decreasing the charge pump frequency (see <u>Table 22 on page 11</u>) and thus reducing the total current consumption. If the charge pump frequency is halved, then the driving capability is halved as well, whereas the output resistance doubles.

#### 7.4.6 Charge pump frequency settings and power efficiency

The PCA9620 offers the possibility to use different frequency settings for the charge pump. Bit CPF controls the frequency at which the charge pump is running (see <u>Table 22 on page 11</u>). This frequency has a direct influence on the current consumption of the IC but also on the charge pump driving capability. Using a lower charge pump frequency decreases the current consumption and the driving capability.

The power efficiency of the charge pump determines in certain applications which frequency settings to choose for the CPF bit. In the example shown in Figure 26, the current consumption was measured with the charge pump set to  $2 \times V_{DD2}$  and with  $V_{DD2} = 3.0 \text{ V}$  and VPR[7:0] set to maximum to obtain the maximum possible  $V_{LCD}$  with this setup, which is close to 6.0 V. The current load on pin  $V_{LCD}$  determines the output power delivered by the IC:

$$P_o = I_{load} \times V_{LCD} \tag{8}$$

The current consumption on pin V<sub>DD2</sub> determines the input power taken by the IC:

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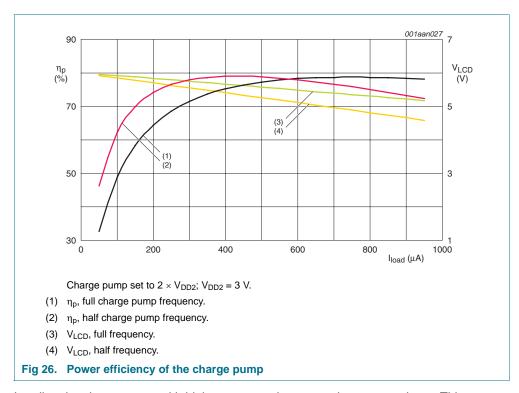
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$$P_i = I_{DD2} \times V_{DD2} \tag{9}$$

The ratio between these two numbers determines the charge pump power efficiency:

$$\eta_p = P_o/P_i \tag{10}$$



Loading the charge pump with higher currents decreases the output voltage. This decrease is determined by the charge pump driving capability, respectively by the output resistance of the charge pump (see <u>Table 35 on page 55</u>).

The power efficiency calculation is only valid when the charge pump is running at its maximum peak frequency and regulates the generated  $V_{LCD}$  voltage with full speed. In this case, the ripple on the  $V_{LCD}$  voltage equals the internal charge pump frequency. Approximately, this could also be calculated with the parameter of the output resistance of the charge pump (see <u>Table 35 on page 55</u>), the load current, and the voltage needed to be provided by using <u>Equation 7 on page 33</u>. This value of  $I_{load}$  is close to the value of the load current needed for the application.

If the application runs with  $V_{DD2}=3.0$  V, the load currents are up to 400  $\mu$ A (DC measured), and the  $V_{LCD}$  generated voltages are up to 5.0 V, then - concerning power efficiency - it would be the best to have a charge pump frequency set to half frequency.

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In case it is desired to change the charge pump frequency, it is recommended to make a graph like Figure 26 and understand what the application requirements are. This would basically imply to find out what would be the maximum  $V_{LCD}$  requirements and what would be the maximum load currents required. Then it can be decided which is the best setting of bit CPF.

Tuning the charge pump frequency might be a difficult task to do and requires good knowledge of the application in which the IC is being used; therefore, NXP recommends to keep the CPF bit set logic 0 to have the maximum charge pump frequency, thus having the maximum driving strength.

#### 7.4.7 Temperature readout

The PCA9620 has a built-in temperature sensor which provides a 8 bit digital value, TD[7:0], of the ambient temperature. This value can be read through the I<sup>2</sup>C interface (see Figure 49 on page 52). The actual temperature is determined from TD[7:0] using Equation 11:

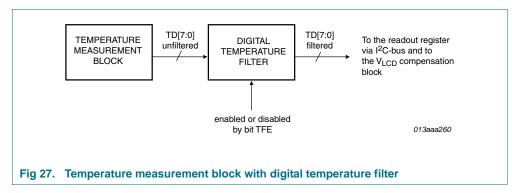
$$T(^{\circ}C) = 0.9375 \times TD[7:0] - 40$$
 (11)

The measurement needs about 5 ms to complete and is repeated periodically as soon as bit TME is set logic 1 (see <u>Table 9 on page 7</u>). The time between measurements is linked to the system clock and hence varies with changes in the chosen frame frequency, see <u>Table 28</u>.

Table 28. Temperature measurement update rate

Selected frame frequency	Temperature measurement update rate
60 Hz	3.3 s
200 Hz	1 s
300 Hz	0.67 s

Due to the nature of a temperature sensor, oscillations on the  $V_{LCD}$  may occur. To avoid this, a filter has been implemented in PCA9620. The system is shown in Figure 27.

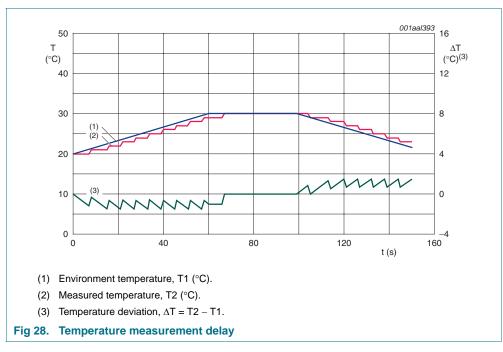


Like any other filtering, the digital temperature filter (see <u>Figure 27</u>) introduces a certain delay in the measurement of temperature. This behavior is illustrated in <u>Figure 28</u>.

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This delay may cause undesired effects at start-up when the environment temperature may be different than the reset value of the PCA9620 which is 20  $^{\circ}$ C. In this case it takes up to 30 s till the correct measured temperature value will be available. A control bit, TFE, is implemented to enable or disable the digital temperature filter. This bit is set logic 0 by default which means that the filter is disabled and the unfiltered environment temperature value is available to calculate the desired  $V_{\rm LCD}$ .

## 7.4.8 Temperature compensation of V<sub>LCD</sub>

Due to the temperature dependency of the liquid crystal viscosity the LCD controlling voltage  $V_{LCD}$  might have to be adjusted at different temperatures to maintain optimal contrast. The temperature behavior of the liquid comes from the LCD manufacturer. The slope has to be set to compensate for the liquid behavior. Internal temperature compensation may be enabled via bit TCE.

The ambient temperature range is split up into four equally sized regions and a different temperature coefficient can be applied to each (see <u>Figure 29</u>). Each coefficient can be selected from a choice of eight different slopes. Each one of these coefficients (see <u>Table 29</u>) may be independently selected via the temp-comp-SLA to temp-comp-SLD commands (see <u>Table 4 on page 5</u>).

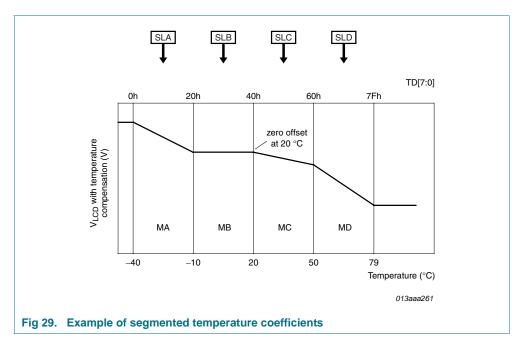
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SLA[2:0] to SLD[2:0] value	Corresponding slope factor (mV/°C)	Temperature coefficients MA, MB, MC, MD[1]
000[2]	0	0.00
001	-4	-0.125
010	-8	-0.25
011	-16	-0.5
100	-40	-1.25
101	+4	0.125
110	+8	0.25
111	+16	0.5

<sup>[1]</sup> The relationship between the temperature coefficients MA to MD and the slope factor is derived from the following equation:  $Mx = \frac{0.9375}{0.03} \times \frac{slope}{1000}$ .

[2] Default value.

The slope factors imply a linear correction, however the implementation is set in steps of 30 mV (parameter n in Table 27 on page 31).



**Remark:** After reset,  $V_{LCD}$  is fixed because the VPR[7:0] bit field is reset logic 0. The value of VT[7:0] is generated by the reset value of TD[7:0] (40h, representing 20 °C). Temperature compensation is implemented by adding an offset VT[7:0] to the VPR[7:0] value. VT[7:0] is a two's complement number that equals 0h at 20 °C. The final result for  $V_{LCD}$  calculation is an 8-bit positive number (see Equation 6 on page 31).

**Remark:** Care must be taken that the ranges of VPR[7:0] and VT[7:0] don't cause clipping and hence undesired results. The device will not permit overflow or underflow and will clamp results to either end of the range.

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The  $V_{offset(LCD)}$  value can be calculated with the equations given in Table 30:

$$V_{offset(LCD)} = m \times V_T \tag{12}$$

Table 30. Calculation of the temperature compensated voltage V<sub>T</sub>

	•	
Temperature range	TD[7:0]	Offset equation for V <sub>T</sub>
$T \le -40$ °C	0h	$V_T = -32 \times MA - 32 \times MB$
$-40~^{\circ}C \le T \le -10~^{\circ}C$	0h to 20h	$V_T = (TD[7:0] - 32) \times MA - 32 \times MB$
-10 °C < T ≤ 20 °C	21h to 40h	$V_T = (TD[7:0](-64)) \times MB$
$20~^{\circ}\text{C} < \text{T} \le 50~^{\circ}\text{C}$	41h to 60h	$V_T = (TD[7:0] - 64) \times MC$
50 °C < T < 80 °C	61h to 7Eh	$V_T = (TD[7:0] - 96) \times MD + 32 \times MC$
80 °C ≤ T	7Fh[1]	$V_T = 31 \times MD + 32 \times MC$

<sup>[1]</sup> No temperature compensation is possible above 80 °C. Above this value, the system maintains the compensation value from 80 °C.

**Example**: Assumed that 
$$T_{amb} = -8$$
 °C;  $TD[7:0] = 22h$ ;  $MB = -0.5$ :  $V_{offset(LCD)} = m \times V_T = m \times (TD[7:0] - 64) \times MB = 30mV \times ((34 - 64) \times -0.5) = 30mV \times -30 \times -0.5 = 450mV$ 

The VT[7:0] term is calculated using the digital temperature value TD[7:0] which is provided by the temperature measurement block (Section 7.4.7). Therefore the accuracy of the temperature measurement block ( $T_{acc}$ , see Table 35 on page 55) will be directly translated to the LCD voltage deviation  $\Delta V_{LCD}$ .

Since VT[7:0] = f[T,slope] and  $T_{acc}$  = ±6 °C then  $\Delta V_T = T_{acc} \times slope$ , where slope has one of the possible values specified in <u>Table 29</u>. This term will be added to the total LCD voltage deviation  $\Delta V_{offset(LCD)tot}$  over the temperature range. So the total  $V_{LCD}$  offset will be:  $\Delta V_{offset(LCD)tot} = \Delta V_{LCD} + \Delta V_T$ .

## 7.5 Oscillator

The internal logic and LCD drive signals of the PCA9620 are timed by a frequency  $f_{clk}$  which either is the built-in oscillator frequency  $f_{osc}$  or equals an external clock frequency.

## 7.5.1 Internal oscillator

When the internal oscillator is used, it is possible to make the clock signal available on pin CLK by using the oscillator-ctrl command (see <u>Table 7 on page 6</u>). If this is not intended, pin CLK should be left open. At power-on the signal at pin CLK is disabled and pin CLK is in 3-state.

The duty cycle of the output clock provided on the CLK pin is not always 50 : 50. <u>Table 17 on page 9</u> shows the expected duty cycle for each of the chosen frame frequencies.

#### 7.5.2 External clock

In applications where an external clock needs to be applied to the PCA9620, bit OSC (see Table 7 on page 6) must be set logic 1. In this case pin CLK becomes an input.

The CLK signal is a signal that is fed into the  $V_{DD1}$  domain so it must have an amplitude equal to the  $V_{DD1}$  voltage supplied to the chip and be referenced to  $V_{SS}$ .

The clock frequency (f<sub>clk</sub>) determines the LCD frame frequency f<sub>fr</sub>.

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**Remark:** In case that a external clock is used then this clock signal must always be supplied to the device; removing the clock may freeze the LCD in a DC state, which is not suitable for the liquid crystal. Removal of the clock is possible when following the correct procedures. See Figure 12 on page 19 and Figure 13 on page 20.

# 7.5.3 Timing and frame frequency

The timing of the PCA9620 organizes the internal data flow of the device. This includes the transfer of display data from the display RAM to the display segment outputs. The timing also generates the LCD frame frequency which it derives as an integer division of the clock frequency. The frame frequency is a fixed division of the internal clock or of the frequency applied to pin CLK when an external clock is used:

$$f_{fr} = \frac{f_{clk}}{48} \tag{13}$$

When the internal clock is used, the clock and frame frequency can be programmed by software such that the nominal frame frequency can be chosen in steps of 10 Hz in the range of 60 Hz to 300 Hz (see <u>Table 17 on page 9</u>). Furthermore the nominal frame frequency is factory-calibrated with an accuracy of  $\pm 15$  %.

When the internal clock is enabled at pin CLK by using bit COE, the duty ratio of the clock may change when choosing different values for the frame frequency prescaler. <u>Table 17 on page 9</u> shows the different output duty ratios for each frame frequency prescaler setting.

## 7.6 Backplane outputs

The LCD drive section includes eight backplane outputs: BP0 to BP7. The backplane output signals are generated based on the selected LCD multiplex drive mode.

<u>Table 31</u> describes which outputs are active for each of the multiplex drive modes and what signal is generated.

Table 31. Mapping of output pins and corresponding output signals with respect to the multiplex driving mode

Multiplex	Output p	Output pin									
drive mode	BP0	BP1	BP2	ВР3	BP4	BP5	BP6	ВР7			
illoue	Signal										
1:8	BP0	BP1	BP2	BP3	BP4	BP5	BP6	BP7			
1:6	BP0	BP1	BP2	BP3	BP4	BP5	BP0[1]	BP1[1]			
1:4	BP0	BP1	BP2	BP3	BP0[1]	BP1[1]	BP2[1]	BP3[1]			
1:2	BP0	BP1	BP0[1]	BP1[1]	BP0[1]	BP1[1]	BP0[1]	BP1 <sup>11</sup>			
static	BP0	BP0[1]	BP0[1]	BP0[1]	BP0[1]	BP0[1]	BP0[1]	BP0[1]			

<sup>[1]</sup> These pins may optionally be connected to the display to improve drive strength. Connect only with the corresponding output pin carrying the same signal. If not required they can be left open-circuit.

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## 7.7 Segment outputs

The LCD drive section includes 60 segment outputs (S0 to S59) which must be connected directly to the LCD. The segment output signals are generated based on the multiplexed backplane signals and with data resident in the display register. When less than 60 segment outputs are required, the unused segment outputs must be left open-circuit.

# 7.8 Display register

The display register holds the display data while the corresponding multiplex signals are generated.

## 7.9 Display RAM

The display RAM is a static  $60 \times 8$ -bit RAM which stores LCD data. Logic 1 in the RAM bit map indicates the on-state of the corresponding LCD element; similarly, logic 0 indicates the off-state.

There is a one-to-one correspondence between

- the bits in the RAM bitmap and the LCD elements
- the RAM columns and the segment outputs
- the RAM rows and the backplane outputs.

The display RAM bit map, Figure 30, shows row 0 to row 7 which correspond with the backplane outputs BP0 to BP7, and column 0 to column 59 which correspond with the segment outputs S0 to S59. In multiplexed LCD applications the data of each row of the display RAM is time-multiplexed with the corresponding backplane (row 0 with BP0, row 1 with BP1 and so on).

When display data is transmitted to the PCA9620 the display bytes received are stored in the display RAM in accordance with the selected LCD multiplex drive mode. The data is stored as it arrives and does not wait for the acknowledge cycle as with the commands. Depending on the current multiplex drive mode, data is stored singularly, in pairs, quadruples, sextuples or bytes.

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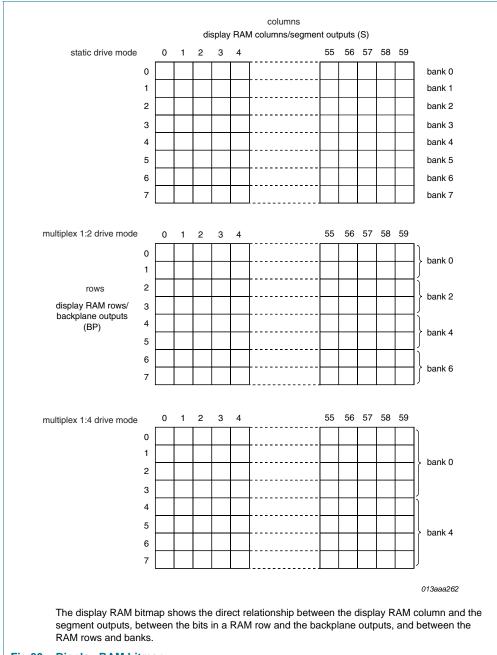


Fig 30. Display RAM bitmap

# 7.9.1 Data pointer

The addressing mechanism for the display RAM is realized using the data pointer. This allows the loading of an individual display data byte, or a series of display data bytes into any location of the display RAM. The sequence commences with the initialization of the data pointer by the load-data-pointer command. Following this command, an arriving data byte is stored starting at the display RAM address indicated by the data pointer.

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The data pointer is automatically incremented in accordance with the chosen LCD multiplex drive mode configuration. That is, after each byte is stored, the contents of the data pointer are incremented

- by eight (static drive mode)
- by four (1:2 multiplex drive mode)
- by two (1:4 multiplex drive mode)
- by one or two (1:6 multiplex drive mode), see Figure 37 on page 45
- by one (1:8 multiplex drive mode)

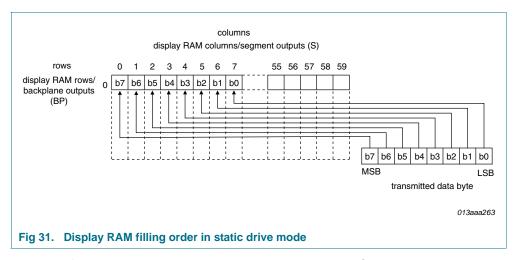
If the data pointer reaches the end of the RAM row it is automatically wrapped around to address 0. This means that it can be continuously written to or read from the display RAM.

The data pointer should always be set to an address where the remaining RAM is divisible by eight because odd bits will be discarded (see <u>Figure 32</u>). This behavior is actually only shown in static drive mode because of the fact that the 60 RAM cells can't be divided by eight without remainder.

If an I<sup>2</sup>C-bus data access is terminated early then the state of the data pointer is unknown. The data pointer must then be re-written prior to further RAM accesses.

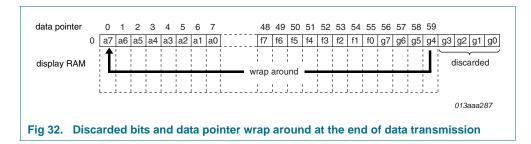
## 7.9.1.1 RAM filling in static drive mode

In the static drive mode the eight transmitted data bits are placed in eight successive display RAM columns in row 0 (see Figure 31).



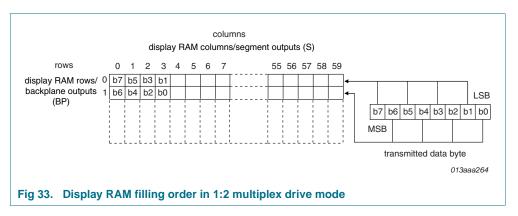
In order to fill the whole RAM row, 8 bytes must be sent to the PCA9620, but the last 4 bits from the last byte are discarded, and the data pointer is wrapped around to column 0 to start a possible RAM content update (see <u>Figure 32</u>).

### Universal LCD driver for low multiplex rates

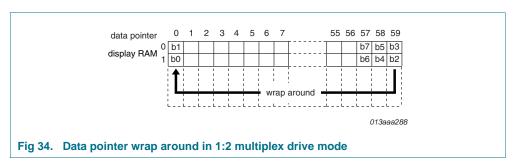


## 7.9.1.2 RAM filling in 1:2 multiplex drive mode

In the 1:2 multiplex drive mode the eight transmitted data bits are placed in four successive display RAM columns of two rows (see Figure 33).



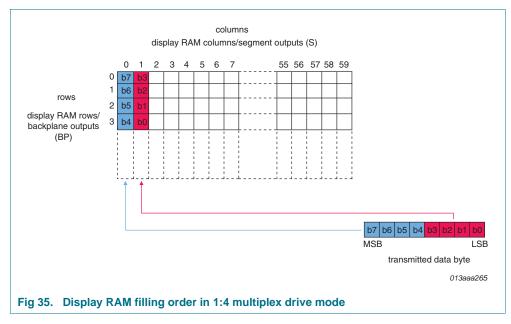
In order to fill the whole two RAM rows 15 bytes need to be sent to the PCA9620. After the last byte sent the data pointer is wrapped around to column 0 to start a possible RAM content update (see <u>Figure 34</u>). Even if a data byte is transmitted during the wrapping of the data pointer, then all the bits in the byte will be written correctly.



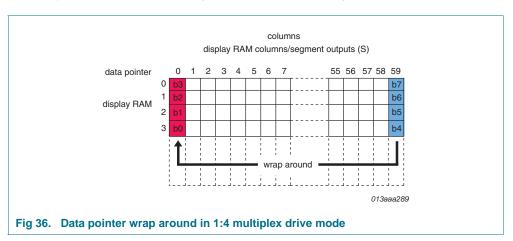
## 7.9.1.3 RAM filling in 1:4 multiplex drive mode

In the 1:4 multiplex drive mode the eight transmitted data bits are placed in two successive display RAM columns of four rows (see Figure 35).

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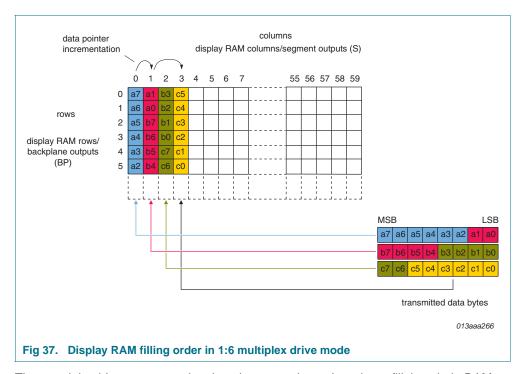
In order to fill the whole four RAM rows 30 bytes need to be sent to the PCA9620. After the last byte sent, the data pointer is wrapped around to column 0 to start a possible RAM content update (see <u>Figure 36</u>). Even if a data byte is transmitted during the wrapping of the data pointer, all the bits in the byte will be written correctly.



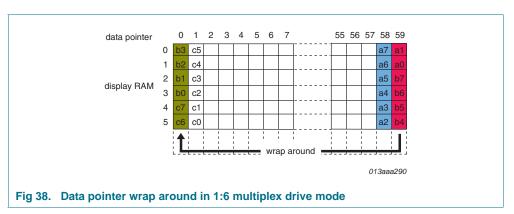
#### 7.9.1.4 RAM filling in 1:6 multiplex drive mode

In the 1:6 multiplex drive mode the RAM is organized in six rows and 60 columns. The eight transmitted data bits are placed in such a way, that a column is filled up (see Figure 37).

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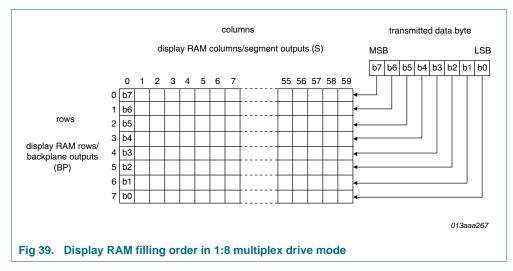
The remaining bits are wrapped up into the next column. In order to fill the whole RAM addresses 45 bytes need to be sent to the PCA9620. After the last byte sent the data pointer is wrapped around to column 0 to start a possible RAM content update (see <u>Figure 38</u>). Even if a data byte is transmitted during the wrapping of the data pointer, all the bits in the byte will be written correctly.



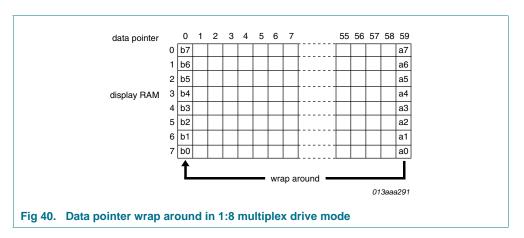
## 7.9.1.5 RAM filling in 1:8 multiplex drive mode

In the 1:8 multiplex drive mode the eight transmitted data bits are placed into eight rows of one display RAM column (see Figure 39).

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In order to fill the whole RAM addresses 60 bytes need to be sent to the PCA9620. After the last byte sent the data pointer is wrapped around to column 0 to start a possible RAM content update (see <u>Figure 40</u>). In this case there is no situation possible where a transmitted data byte can be written over the RAM boundary.

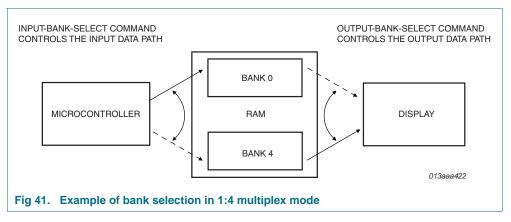


#### 7.9.2 Bank selection

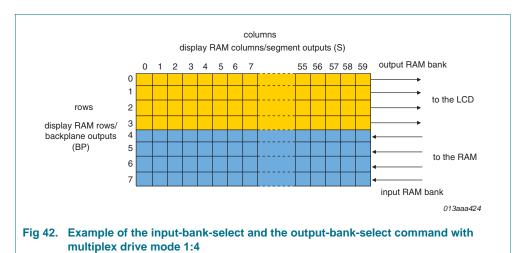
A RAM bank can be thought of as a collection of RAM rows. The PCA9620 includes a RAM bank switching feature in the static, 1:2, and 1:4 multiplex drive modes.

The RAM bank switching gives the provision for preparing display information in an alternative bank and to be able to switch to it once it is complete. Input and output banks can be set independently from one another with the input-bank-select and the output-bank-select commands; Figure 41 shows the concept.

### Universal LCD driver for low multiplex rates



In <u>Figure 41</u> an example is shown for 1:4 multiplex drive mode where the displayed data is read from the first four rows of the memory (bank 0), while the transmitted data is stored in the second four rows of the memory (bank 4) which is currently not accessed for the reading. Therefore different content can be loaded into the first and second four RAM rows which will be immediately displayed on the LCD by switching it with the output-bank-select command (see Figure 42).



#### 7.9.2.1 Input-bank-select

The input-bank-select command (see <u>Table 18 on page 10</u>) loads display data into the display RAM in accordance with the selected LCD drive configuration.

- In static drive mode, an individual content can be stored in each RAM bank (bank 0 to bank 7 which corresponds to row 0 to row 7).
- In 1:2 multiplex drive mode, individual content for RAM bank 0 (row 0 and row 1), RAM bank 2 (row 2 and row 3), RAM bank 4 (row 4 and 5) and RAM bank 6 (row 6 and row 7) can be stored.
- In 1:4 multiplex drive mode individual content can be stored in RAM bank 0 (row 0 to row 3) and RAM bank 4 (row 4 to row 7).

The input-bank-select command works independently to the output-bank-select.

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### Universal LCD driver for low multiplex rates

## 7.9.2.2 Output-bank-select

The output-bank-select command (see <u>Table 19 on page 10</u>) selects the display RAM transferring it to the display register in accordance with the selected LCD drive configuration.

- In the static drive mode it is possible to request the content of RAM bank 1 (row 1) to RAM bank 7 (row 7) for display instead of the default RAM bank 0 (row 0).
- In 1:2 multiplex drive mode, the content of RAM bank 2 (row 2 and row 3) or of RAM bank 4 (row 4 and row 5) or of RAM bank 6 (row 6 and row 7) may be selected instead of the default RAM bank 0 (row 0 and row 1).
- In 1:4 multiplex drive mode, the content of RAM bank 4 (row 4, 5, 6, and 7) may be selected instead of RAM bank 0 (row 0, 1, 2, and 3).

The output-bank-select command works independently to the input-bank-select.

Downloaded from Elcodis.com electronic components distributor

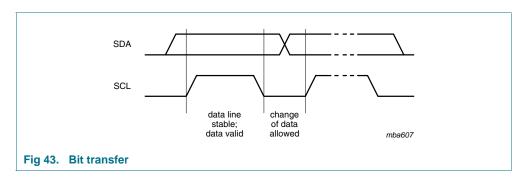
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## 8. I<sup>2</sup>C-bus interface characteristics

The I<sup>2</sup>C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial DAta line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

## 8.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal (see Figure 43).



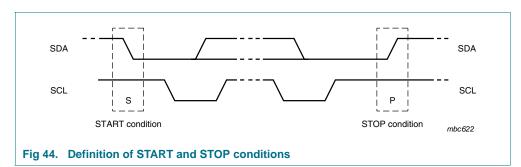
## 8.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy.

A HIGH-to-LOW change of the data line, while the clock is HIGH is defined as the START condition (S).

A LOW-to-HIGH change of the data line while the clock is HIGH is defined as the STOP condition (P).

The START and STOP conditions are shown in Figure 44.



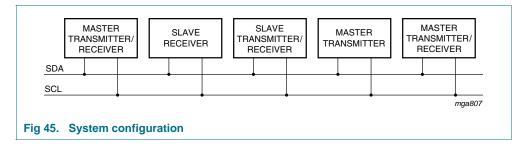
# 8.3 System configuration

A device generating a message is a transmitter; a device receiving a message is the receiver. The device that controls the message is the master; and the devices which are controlled by the master are the slaves. The system configuration is shown in <u>Figure 45</u>.

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### Universal LCD driver for low multiplex rates

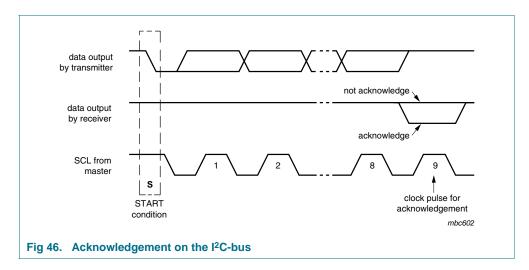


## 8.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of eight bits is followed by an acknowledge cycle.

- A slave receiver which is addressed must generate an acknowledge after the reception of each byte.
- Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.
- The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration).
- A master receiver must signal an end of data to the transmitter by not generating an
  acknowledge on the last byte that has been clocked out of the slave. In this event the
  transmitter must leave the data line HIGH to enable the master to generate a STOP
  condition.

Acknowledgement on the I<sup>2</sup>C-bus is shown in Figure 46.



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## 8.5 I<sup>2</sup>C-bus controller

The PCA9620 acts as an I<sup>2</sup>C-bus slave receiver. It does not initiate I<sup>2</sup>C-bus transfers or transmit data to an I<sup>2</sup>C-bus master receiver. The only data output from PCA9620 are the acknowledge signals and the temperature readout byte of the selected device.

## 8.6 Input filters

To enhance noise immunity in electrically adverse environments, RC low-pass filters are provided on the SDA and SCL lines.

## 8.7 I<sup>2</sup>C-bus slave address

Device selection depends on the I<sup>2</sup>C-bus slave address.

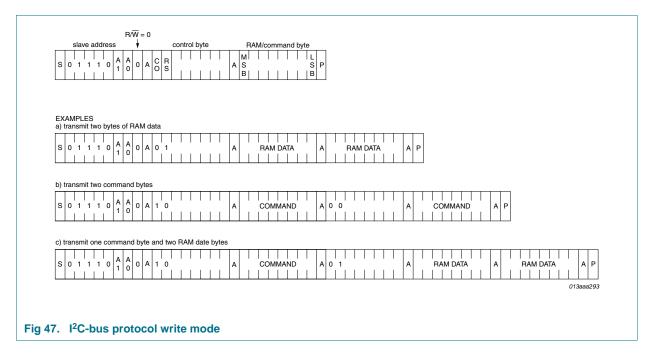
Four different I<sup>2</sup>C-bus slave addresses can be used to address the PCA9620 (see Table 32).

Table 32. I<sup>2</sup>C slave address

	Slave address							
Bit	7	6	5	4	3	2	1	0
	MSB							LSB
slave address	0	1	1	1	0	A1	A0	R/W

The least significant bit of the slave address byte is bit  $R/\overline{W}$ . Bit 1 and bit 2 of the slave address are defined by connecting the inputs A0 and A1 to either  $V_{SS}$  (logic 0) or  $V_{DD}$  (logic 1). Therefore, four instances of PCA9620 can be distinguished on the same  $I^2C$ -bus.

## 8.8 I<sup>2</sup>C-bus protocol



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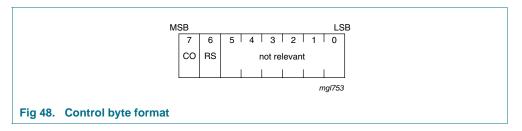
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The  $I^2C$ -bus protocol is shown in Figure 47. The sequence is initiated with a START condition (S) from the  $I^2C$ -bus master which is followed by one of the four PCA9620 slave addresses available. All PCA9620's with the corresponding A1 and A0 level acknowledge in parallel to the slave address, but all PCA9620 with the alternative A1 and A0 levels ignore the whole  $I^2C$ -bus transfer.

After acknowledgement, a control byte follows which defines if the next byte is RAM or command information. The control byte also defines if the next byte is a control byte or further RAM or command data.

Table 33. Control byte description

Bit	Symbol	Value	Description
DIL	Syllibol	value	Description
7 CO			continue bit
		0	last control byte
		1	control bytes continue
6	RS		register selection
		0	command register
		1	data register
5 to 0	-	-	not relevant

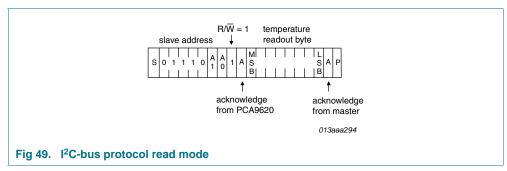


In this way it is possible to configure the device and then fill the display RAM with little overhead.

The display bytes are stored in the display RAM at the address specified by the data pointer.

The acknowledgement after each byte is made only by the (A0 and A1) addressed PCA9620. After the last display byte, the I<sup>2</sup>C-bus master issues a STOP condition (P). Alternatively a START may be issued to RESTART an I<sup>2</sup>C-bus access.

In case that a temperature readout (byte TD[7:0]) is made the  $R/\overline{W}$  bit must be logic 1 and then the next data byte following is provided by the PCA9620 as shown in Figure 49.

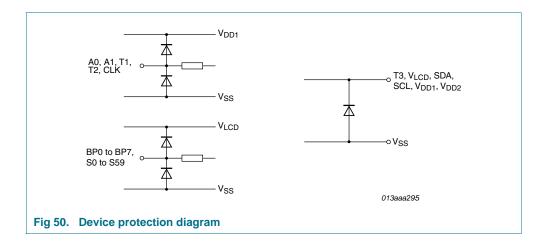


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## Universal LCD driver for low multiplex rates

# 9. Internal circuitry



### Universal LCD driver for low multiplex rates

# 10. Limiting values

## **CAUTION**



Static voltages across the liquid crystal display can build up when the LCD supply voltage  $(V_{LCD})$  is on while the IC supply voltage  $(V_{DD})$  is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts,  $V_{LCD}$  and  $V_{DD}$  must be applied or removed together.

Table 34. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD1}$	supply voltage 1	analog and digital	-0.5	+6.5	V
$V_{DD2}$	supply voltage 2	charge pump	-0.5	+6.5	V
I <sub>DD1</sub>	supply current 1	analog and digital	-50	+50	mA
I <sub>DD2</sub>	supply current 2	charge pump	-50	+50	mA
$V_{LCD}$	LCD supply voltage		-0.5	+10	V
I <sub>DD(LCD)</sub>	LCD supply current		-50	+50	mA
Vi	input voltage	on pins CLK, SDA, SCL, A0, A1, T1, T2, T3	-0.5	+6.5	V
II	input current		-10	+10	mA
Vo	output voltage	on pins S0 to S59, BP0 to BP7	-0.5	+10	V
		on pins SDA, CLK	-0.5	+6.5	V
Io	output current		-10	+10	mA
I <sub>SS</sub>	ground supply current		-50	+50	mA
P <sub>tot</sub>	total power dissipation		-	400	mW
P/out	power dissipation per output		-	100	mW
V <sub>ESD</sub>	electrostatic discharge	НВМ	<u>[1]</u> -	±4000	V
	voltage	CDM	[2] _	±1500	V
I <sub>lu</sub>	latch-up current		[3] _	100	mA
T <sub>stg</sub>	storage temperature		[ <u>4</u> ] –65	+150	°C
T <sub>amb</sub>	ambient temperature	operating device	-40	+105	°C

<sup>[1]</sup> Pass level; Human Body Model (HBM), according to Ref. 6 "JESD22-A114".

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<sup>[2]</sup> Pass level; Charged-Device Model (CDM), according to Ref. 7 "JESD22-C101".

<sup>[3]</sup> Pass level; latch-up testing according to Ref. 8 "JESD78" at maximum ambient temperature (T<sub>amb(max)</sub>).

<sup>[4]</sup> According to the NXP store and transport requirements (see Ref. 10 "NX3-00092") the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %. For long term storage products divergent conditions are described in that document.

## Universal LCD driver for low multiplex rates

# 11. Static characteristics

 Table 35.
 Static characteristics

 $V_{DD1}$  = 2.5 V to 5.5 V;  $V_{DD2}$  = 2.5 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 2.5 V to 9.0 V;  $T_{amb}$  = -40 °C to +105 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Un
Supplies							
$V_{DD1}$	supply voltage 1			2.5	-	5.5	V
$V_{DD2}$	supply voltage 2	$V_{DD2} \ge V_{DD1}$		2.5	-	5.5	V
$V_{LCD}$	LCD supply voltage	$V_{LCD} \ge V_{DD2}$	<u>[1]</u>	2.5	-	9.0	V
$\Delta V_{LCD}$	LCD voltage variation	$V_{LCD} = 5.0 \text{ V to } 9.0 \text{ V}$	[2]				
		$T_{amb} = -40  ^{\circ}\text{C} \text{ to } -10  ^{\circ}\text{C}$		-100	-	+100	m\
		$T_{amb} = -10  ^{\circ}\text{C} \text{ to } +70  ^{\circ}\text{C}$		-70	-	+70	m\
		T <sub>amb</sub> = +70 °C to +105 °C		-100	-	+100	m\
I <sub>DD(pd)</sub>	power-down mode supply current	on pin $V_{DD1}$	[3][4]	-	1.0	3.0	μА
I <sub>DD1</sub>	supply current 1		[4][5]	-	100	200	μΑ
$I_{DD2}$	supply current 2	f <sub>osc</sub> = 9.6 kHz					
		charge pump off; external V <sub>LCD</sub>	[4][5]	-	0.5	3.0	μΑ
		charge pump on; internal V <sub>LCD</sub>	[4][6]	-	250	550	μΑ
I <sub>DD(LCD)</sub>	LCD supply current	external V <sub>LCD</sub>	[4][7]	-	125	250	μΑ
I <sub>LCD(pd)</sub>	power-down LCD current	external V <sub>LCD</sub>	[3][4]	-	12	35	μΑ
R <sub>O</sub> ou	output resistance	of charge pump (driving capabilities)					
		charge pump set to $2 \times V_{DD2}$ ; $I_{load} = 3 \text{ mA (on pin V}_{LCD})$	[8]	0.2	0.85	1.6	kΩ
		charge pump set to $3 \times V_{DD2}$ ; $I_{load} = 2 \text{ mA (on pin V}_{LCD})$	[9]	2.0	3.2	4.5	kΩ
T <sub>acc</sub>	temperature accuracy	readout temperature error; V <sub>DD1</sub> = 5.0 V					
		$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +105  ^{\circ}\text{C}$		-6	-	+6	°C
		T <sub>amb</sub> = 27 °C		-4	-	+4	°C
Logic							
VI	input voltage			$V_{SS}-0.5$	-	$V_{DD} + 0.5$	V
V <sub>IL</sub>	LOW-level input voltage	on pins CLK, A1, A0		-	-	$0.3V_{DD}$	V
V <sub>IH</sub>	HIGH-level input voltage	on pins CLK, A1, A0		$0.7V_{DD}$	-	-	V
Vo	output voltage			-0.5	-	$V_{DD} + 0.5$	V
V <sub>OH</sub>	HIGH-level output voltage	on pin CLK		$0.8V_{DD}$	-	-	٧
V <sub>OL</sub>	LOW-level output voltage	on pin CLK		-	-	$0.2V_{DD}$	٧
Іон	HIGH-level output current	output source current; $V_{OH} = 4.6 \text{ V}; V_{DD} = 5 \text{ V}; \text{ on pin CLK}$		1	-	-	m/
l <sub>OL</sub>	LOW-level output current	output sink current; V <sub>OL</sub> = 0.4 V; V <sub>DD</sub> = 5 V; on pin CLK		1	-	-	m/
V <sub>POR</sub>	power-on reset voltage		[10]	-	-	1.6	٧
	leakage current	$V_i = V_{DD}$ or $V_{SS}$ ; on pins CLK, A1,	[11]	_	0	_	μΑ

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### Universal LCD driver for low multiplex rates

Table 35. Static characteristics ... continued

 $V_{DD1}$  = 2.5 V to 5.5 V;  $V_{DD2}$  = 2.5 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 2.5 V to 9.0 V;  $T_{amb}$  = -40 °C to +105 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sup>2</sup> C-bus; pir	ns SDA and SCL						
VI	input voltage			$V_{SS}-0.5$	-	5.5	V
V <sub>IL</sub>	LOW-level input voltage	pins SCL, SDA		-	-	$0.3V_{DD}$	V
V <sub>IH</sub>	HIGH-level input voltage	pins SCL, SDA		$0.7V_{DD}$	-	-	V
Vo	output voltage	pins SCL, SDA		-0.5	-	5.5	V
I <sub>OL</sub>	LOW-level output current	$V_{OL} = 0.4 \text{ V}$ ; $V_{DD} = 5 \text{ V}$ ; on pin SDA		3	-	-	mA
IL	leakage current	$V_I = V_{DD}$ or $V_{SS}$	[11]	-	0	-	μΑ
LCD output	ts .						
$\Delta V_{O}$	output voltage variation	on pins BP0 to BP7	[12]	-15	-	+15	mV
		on pins S0 to S59	[13]	-15	-	+15	mV
R <sub>O</sub>	output resistance	V <sub>LCD</sub> = 7 V; on pins BP0 to BP7	[14]	0.3	0.8	1.5	kΩ
		V <sub>LCD</sub> = 7 V; on pins S0 to S59	[14]	0.6	1.5	3	kΩ

<sup>[1]</sup> When supplying external  $V_{LCD}$  it must be  $V_{LCD} \ge V_{DD2}$ . Also when using the internal charge pump to generate a certain  $V_{LCD}$ , VPR[7:0] must be set to a value that the voltage is higher than  $V_{DD2}$  (see Section 7.4.3 on page 31).

- [8]  $V_{DD2} = 5.0 \text{ V}$ ; charge pump set to  $2 \times V_{DD2}$ ; VPR[7:0] set for  $V_{LCD} = 9.0 \text{ V}$ ; display disabled; CPF (see Table 22 on page 11) set logic 0.
- [9]  $V_{DD2} = 4.0 \text{ V}$ ; charge pump set to  $3 \times V_{DD2}$ ; VPR[7:0] set for  $V_{LCD} = 9.0 \text{ V}$ ; display disabled; CPF (see Table 22 on page 11) set logic 0.
- [10] If  $V_{DD1} > V_{POR}$  then no reset occurs.
- [11] In case of an ESD event, the value may increase slightly.
- [12] Variation between any 2 backplanes on a given voltage level; static measured.
- [13] Variation between any 2 segments on a given voltage level; static measured.
- [14] Outputs measured one at a time.

<sup>[2]</sup> Calibrated at testing stage with V<sub>DD1</sub> = V<sub>DD2</sub> = 5.0 V. V<sub>LCD</sub> temperature compensation is disabled.

<sup>[3]</sup> Display is disabled; I<sup>2</sup>C-bus inactive; temperature measurement disabled.

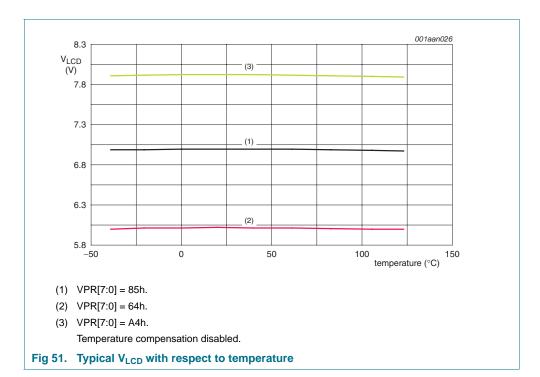
<sup>[4]</sup> The typical value is defined at  $V_{DD1} = V_{DD2} = 5.0 \text{ V}$ ,  $V_{LCD} = 7.0 \text{ V}$  and 30 °C.

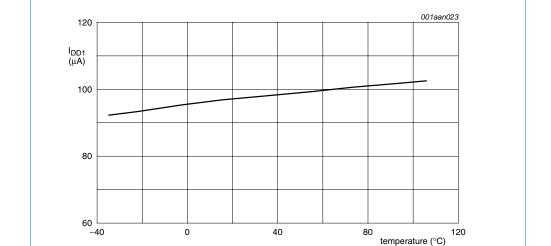
<sup>[5]</sup> Temperature measurement enabled; 1:8 multiplex drive mode; <sup>1</sup>/<sub>4</sub> bias; display enabled; LCD outputs are open circuit; RAM is all written with logic 1; inputs at V<sub>SS</sub> or V<sub>DD</sub>; internal clock with the default prescale factor; I<sup>2</sup>C-bus inactive.

<sup>[6]</sup>  $V_{DD2} = 5.0 \text{ V}$ ; charge pump set to  $2 \times V_{DD2}$ ; VPR[7:0] set for  $V_{LCD} = 7.0 \text{ V}$ ; 1:8 multiplex drive mode;  $\frac{1}{4}$  bias; temperature measurement enabled; display enabled; LCD outputs are open circuit; RAM is all written with logic 1; inputs at  $V_{SS}$  or  $V_{DD}$ ; external clock with 50 % duty factor; I<sup>2</sup>C-bus inactive.

<sup>[7]</sup> External supplied V<sub>LCD</sub> = 7.0 V; 1:8 multiplex drive mode; ½ bias; temperature measurement enabled; display enabled; LCD outputs are open circuit; RAM is all written with logic 1; inputs at V<sub>SS</sub> or V<sub>DD</sub>; external clock with 50 % duty factor; ½ C-bus inactive.

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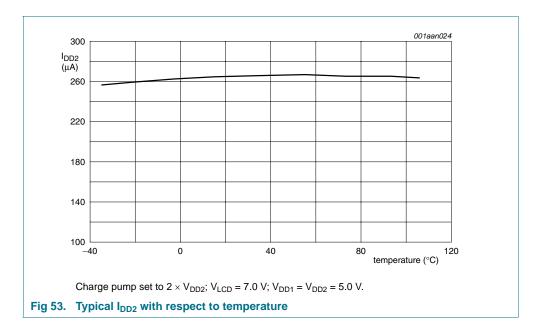


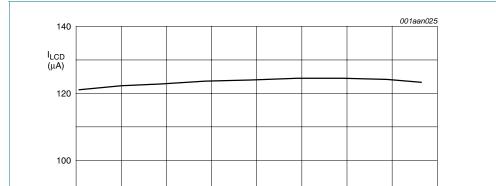


 $V_{DD1} = 5.0 \text{ V}.$ 

Fig 52. Typical  $I_{DD1}$  with respect to temperature

## Universal LCD driver for low multiplex rates





 $V_{LCD}$  = 7.0 V, external supplied;  $V_{DD1}$  =  $V_{DD2}$  = 5.0 V; display enabled, but no display attached.

Fig 54. Typical I<sub>LCD</sub> with respect to temperature

80 <del>-</del>40

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120

temperature (°C)

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# 12. Dynamic characteristics

## Table 36. Dynamic characteristics

 $V_{DD1} = 2.5 \text{ V}$  to 5.5 V;  $V_{DD2} = 2.5 \text{ V}$  to 5.5 V;  $V_{SS} = 0 \text{ V}$ ;  $V_{LCD} = 2.5 \text{ V}$  to 9.0 V;  $T_{amb} = -40 ^{\circ}\text{C}$  to  $+105 ^{\circ}\text{C}$ ; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
f <sub>osc</sub>	oscillator frequency	on pin CLK; see <u>Table 17 on</u> page 9	[1][2]	8160	9600	11 040	Hz
f <sub>clk(ext)</sub>	external clock frequency			450	-	14500	Hz
t <sub>clk(H)</sub>	HIGH-level clock time	external clock source used		33	-	-	μS
t <sub>clk(L)</sub>	LOW-level clock time			33	-	-	μS
Timing chara	cteristics: I <sup>2</sup> C-bus[3]						
f <sub>SCL</sub>	SCL frequency			-	-	400	kHz
t <sub>BUF</sub>	bus free time between a STOP and START condition			1.3	-	-	μS
t <sub>HD;STA</sub>	hold time (repeated) START condition			0.6	-	-	μS
t <sub>SU;STA</sub>	set-up time for a repeated START condition			0.6	-	-	μS
t <sub>VD;DAT</sub>	data valid time		[4]	-	-	0.9	μS
t <sub>VD;ACK</sub>	data valid acknowledge time		[5]	-	-	0.9	μS
$t_{LOW}$	LOW period of the SCL clock			1.3	-	-	μS
t <sub>HIGH</sub>	HIGH period of the SCL clock			0.6	-	-	μS
t <sub>f</sub>	fall time	of both SDA and SCL signals		-	-	0.3	μS
t <sub>r</sub>	rise time	of both SDA and SCL signals		-	-	0.3	μS
C <sub>b</sub>	capacitive load for each bus line			-	-	400	pF
t <sub>SU;DAT</sub>	data set-up time			100	-	-	ns
t <sub>HD;DAT</sub>	data hold time			0	-	-	ns
t <sub>SU;STO</sub>	set-up time for STOP condition			0.6	-	-	μS
t <sub>w(spike)</sub>	spike pulse width			-	-	50	ns

<sup>[1]</sup> Internal calibration made with OTP so that the maximum variation is ±15 % over whole temperature and voltage range. The typical f<sub>osc</sub> generates a typical frame frequency of 200 Hz when the default frequency division factor is used (see Section 7.5.3 on page 39).

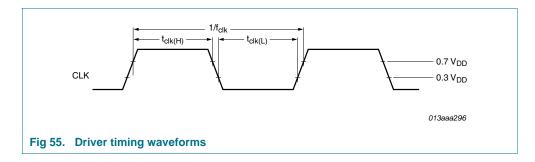
<sup>[2]</sup> The typical value is defined at  $V_{DD1}$  =  $V_{DD2}$  = 5.0 V and 30 °C.

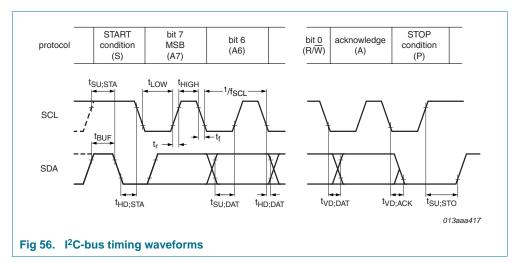
<sup>[3]</sup> All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ .

<sup>[4]</sup>  $t_{VD;DAT}$  = minimum time for valid SDA output following SCL LOW.

<sup>[5]</sup>  $t_{VD;ACK}$  = time for acknowledgement signal from SCL LOW to SDA output LOW.

## Universal LCD driver for low multiplex rates





# 13. Package outline

## LQFP80: plastic low profile quad flat package; 80 leads; body 12 x 12 x 1.4 mm

SOT315-1

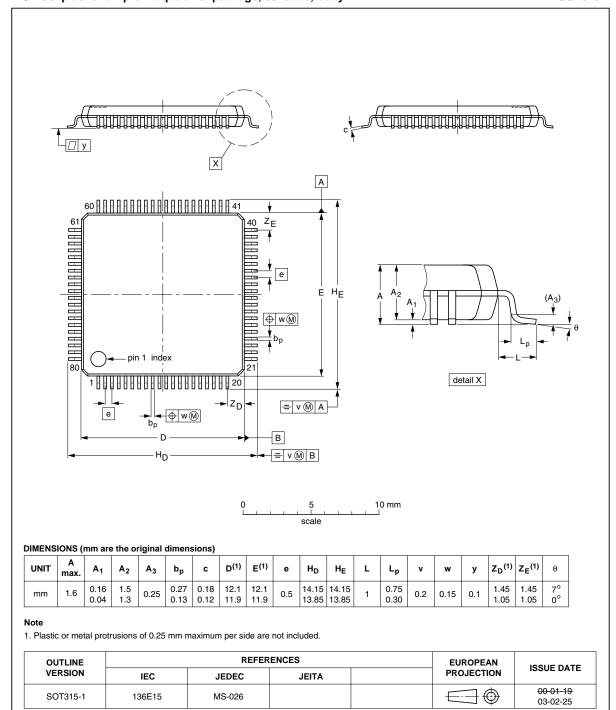


Fig 57. Package outline SOT315-1 (LQFP80)

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### Universal LCD driver for low multiplex rates

# 14. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365* "Surface mount reflow soldering description".

## 14.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

# 14.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- · Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- · Lead-free soldering versus SnPb soldering

## 14.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

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### Universal LCD driver for low multiplex rates

## 14.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 58</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 37 and 38

Table 37. SnPb eutectic process (from J-STD-020C)

Package thickness (mm)	Package reflow temperature (°C)				
	Volume (mm³)				
	< 350	≥ 350			
< 2.5	235	220			
≥ 2.5	220	220			

Table 38. Lead-free process (from J-STD-020C)

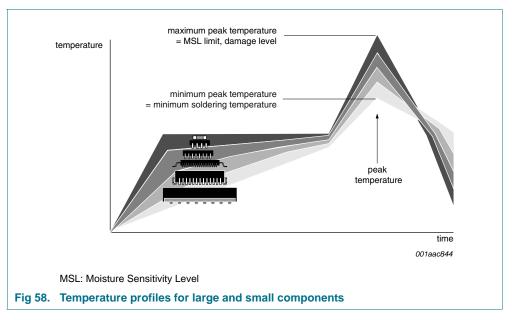
Package thickness (mm)	Package reflow temperature (°C)					
	Volume (mm³)					
	< 350	350 to 2000	> 2000			
< 1.6	260	260	260			
1.6 to 2.5	260	250	245			
> 2.5	250	245	245			

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 58.

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For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

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# 15. Abbreviations

Table 39. Abbreviations

Acronym	Description
AEC	Automotive Electronics Council
CDM	Charged-Device Model
DC	Direct Current
EPROM	Erasable Programmable Read-Only Memory
ESD	ElectroStatic Discharge
НВМ	Human Body Model
I <sup>2</sup> C	Inter-Integrated Circuit bus
IC	Integrated Circuit
LCD	Liquid Crystal Display
LSB	Least Significant Bit
MSB	Most Significant Bit
MSL	Moisture Sensitivity Level
MUX	Multiplexer
OTP	One Time Programmable
PCB	Printed-Circuit Board
POR	Power-On Reset
RC	Resistance-Capacitance
RAM	Random Access Memory
RMS	Root Mean Square
SCL	Serial CLock line
SDA	Serial DAta line
SMD	Surface Mount Device

## Universal LCD driver for low multiplex rates

# 16. References

- [1] AN10365 Surface mount reflow soldering description
- [2] AN10853 ESD and EMC sensitivity of IC
- [3] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [4] IEC 61340-5 Protection of electronic devices from electrostatic phenomena
- [5] IPC/JEDEC J-STD-020D Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- [6] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [7] JESD22-C101 Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [8] JESD78 IC Latch-Up Test
- [9] JESD625-A Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [10] NX3-00092 NXP store and transport requirements
- [11] SNV-FA-01-02 Marking Formats Integrated Circuits
- [12] UM10204 I<sup>2</sup>C-bus specification and user manual

# Universal LCD driver for low multiplex rates

# 17. Revision history

## Table 40. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCA9620 v.1	20101209	Product data sheet	-	-

### Universal LCD driver for low multiplex rates

# 18. Legal information

## 18.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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